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# PATENT ABSTRACTS OF JAPAN

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## ) SUPER-FINE CONDUCTOR FOR WINDING, AND ITS MANUFACTURE

### )Abstract:

PROBLEM TO BE SOLVED: To provide a conductor excellent in electric conductivity, tensile strength, workability and coilability by containing foreign matters of specified diameters in a super-fine conductor containing Ag of a specified ratio, and the balance Cu with inevitable impurities.

SOLUTION: Ag of 1-4.5 wt.% is contained, and the diameter  $d$  ( $\mu\text{m}$ ) of foreign matters is expressed by the formula  $d=0.63D+0.13$ , where  $D$  is the diameter ( $\mu\text{m}$ ) of a super-fine conductor. In a manufacturing method of the super-fine conductor in which a copper alloy cast ingot preferably containing 1-4.5% Ag and the balance Cu with inevitable impurities is cold rolled, the cast ingot is cold rolled with the working ratio of  $\geq 997\%$  so that the dendrite arm space of the casting structure is  $\leq 15 \mu\text{m}$ , and Ag crystal is uniformly dispersed with the diameter of  $\leq 15 \mu\text{m}$ , or annealed at the temperature below the re-crystallization temperature during the cold rolling. The total working ratio can be increased to provide a super-fine conductor and to increase the size of a stock material.

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IMS

im(s)]

im 1] the remainder consists of Cu and an unescapable impurity, including Ag one to 4.5% of the weight (it is after written as %) -- super-thin -- a conductor -- it is -- the above -- super-thin -- a conductor -- the object for coils characterized by the path of the foreign matter contained inside being below  $d_{\text{mum}}$  -- super-thin -- a conductor  
never,  $d=0.63D+0.13$  (the inside of a formula and D are super-thin path  $d_{\text{mum}}$  of a conductor)

im 2] cold working is performed to the copper alloy ingot which the remainder becomes from Cu and an unescapable impurity, including Ag one to 4.5% -- super-thin -- the object for coils according to claim 1 to which it is manufacture method of a conductor and 15 micrometers or less and Ag crystallization object are characterized by the aforementioned ingot distributing uniformly [ the dendrite arm space of a cast structure ] in a diameter 15 micrometers or less, and performing the aforementioned cold working by 99.997% or more of working ratio -- super-thin -- the manufacture method of a conductor

im 3] cold working is performed to the copper alloy ingot which the remainder becomes from Cu and an unescapable impurity, including Ag one to 4.5% -- super-thin -- the manufacture method of a conductor -- it is -- the aforementioned ingot -- the dendrite arm space of a cast structure -- 15 micrometers or less and Ag crystallization object -- a diameter 15 micrometers or less -- uniform -- distributing -- the aforementioned cold working -- on the way -- the object for coils according to claim 1 characterized by being alike and annealing at the temperature of under a crystallizing temperature -- super-thin -- the manufacture method of

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## FAILED DESCRIPTION

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Failed Description of the Invention]

01]

the technical field to which invention belongs] the object for coils which this invention is used for the coil of electronic equipment carried in the back light transformer of the vibrating motor for the stepping motor for clocks, the magnetic head of an audio video or a voice coil, a cellular phone, or pocket bells, various micro relays, a personal computer, or television or a flyback transformer, and an automobile, and is excellent in conductivity, a mechanical property, wire drawing nature, coil nature, etc. -- super-thin -- it is related with a conductor and its manufacture method

02]

Description of the Prior Art] the object for coils -- super-thin -- a conductor is orthopedically operated by the magnetic field after enamel covering etc. Although the tough pitch copper (TPC), the oxygen free copper (OFC), etc. are used for material, it is easy to disconnect these material in wire drawing or coil processing for low strength. If an open circuit arises, a continuous wire drawing machine will be stopped, an open-circuit portion will be removed, the time and effort of setting a wire rod to a dice and setting through and a dice to a wire drawing machine is required, and productivity is injured. Moreover, if an open circuit arises, the defective by the shortage of a unit length will increase. Moreover, if wire drawing is performed through day and night and it disconnects at the night of a perfect non-human system, a wire drawing machine will stop till the next morning, and productivity will fall sharply. Therefore, the ductility conductor which is excellent in the wire drawing nature in which a continuation wire drawing is possible for 24 hours is demanded. a miniaturization and lightweight-izing of recent years and electronic equipment -- following -- 20 micrometers or less -- super-thin -- although a conductor came to be required, incidentally, the amount of wire savings when carrying out the continuation wire drawing of the conductor of the diameter of 20 micrometer the speed 400m/for 24 hours is 1610g, and when the safety factor is taken to 10%, the wire drawing nature of 1800 g/Br is needed furthermore, a path is about 20 micrometers -- super-thin -- since a conductor fractures by the tension of several g, it disconnects by delicate change of a backward tension in an automatic winding machine In a manual winding machine, operation takes skill and there is a problem that it is inferior to productivity again.

03] the object for coils since it is such -- super-thin -- the Cu-Ag system alloy which is excellent in intensity and conductivity as a conductor -- a close-up of a conductor was taken and the proposal of the following \*\* - \*\* was made until now However, in order that all may multiple-times need elevated-temperature annealing, including expensive Ag much, there is a problem in respect of cost and productivity. namely, the object for coils which prevented the open circuit by the lubrication action of Ag which carries out pickling removal of the copper alternatively from the wire rod front face of the copper alloy which contains \*\*Ag 5 to 15%, raises surface Ag concentration, performs repair of a surface blemish, and covering of a foreign matter by Enrichment Ag, and is further rich in ductility -- super-thin -- a conductor (JP,7-96321,A) \*\* the object for high magnetic field generating for magnets which made the copper alloy which contains Ag 15 to 30% the cylindrical ingot of a minor diameter by the continuous casting process, and skipped the process of hot forging and facing -- a conductor (JP,6-93398,A, JP,6-93399,A, JP,6-103809,A) \*\* The path which a copper alloy ingot which contains Ag 15 to 30% was processed at 95% or more of working ratio, and it annealed [ path ], it cold-worked [ path ] at the temperature more than a recrystallizing temperature after that, and recovered elongation and conductivity is the conductor (JP,6-93398,A) of 0.1 or more mm. \*\* The conductor about [ of having ] in annealing at the temperature more than a recrystallizing temperature, having cold-worked the copper alloy ingot which contains Ag 15 to 30%, and having recovered conductivity ] the diameter of 0.9mm (JP,6-93399,A). \*\* The conductor of the diameter of 0.1mm which processed the copper alloy ingot which contains Ag 15 to 30% by 95% or more of working ratio, and annealed and cold-worked at the temperature more than a recrystallizing temperature after that (JP,6-103809,A). \*\* the metal mold of the copper alloy which contains Ag two to 2.8% -- the object for the

marine cables of the diameter of 0.65mm which solution treatment of the ingot was carried out, the multiple-times of the aging treatment was carried out to wire drawing after that, and intensity was raised, and omitted the reinforcement iron braid of a cable -- a conductor (JP,48-44798,A)

[4]

blem(s) to be Solved by the Invention] Then, this invention person etc. inquired wholeheartedly about application of the coil of the copper alloy containing Ag, clarified the addition of Ag suitable for wire drawing nature and coil nature, advances research about the tolerance limit of the cast structure which is further excellent in wire drawing nature and coil nature, and foreign matter size etc., and came to complete this invention. the object for coils this invention excels [ object ] in conductivity, tensile strength, wire drawing nature, coil nature, etc. -- super-thin -- it aims for a conductor and its manufacture method

[5]

ans for Solving the Problem] as for invention according to claim 1, the remainder consists of Cu and an unescapable impurity, including Ag one to 4.5% of the weight (it is hereafter written as %) -- super-thin -- a conductor is -- the above -- super-thin -- a conductor -- the object for coils characterized by the path of the foreign matter contained inside being below  $d_{mum}$  -- super-thin -- it is a conductor However,  $d=0.63D+0.13$  (the inside of a formula D are super-thin path mum of a conductor)

[6] It is the manufacture method of a conductor. invention according to claim 2 performs cold working to the copper alloy ingot which the remainder becomes from Cu and an unescapable impurity, including Ag one to 4.5% -- super-thin -- the aforementioned ingot the object for coils according to claim 1 to which the dendrite arm space of a cast structure is characterized by for 15 micrometers or less and Ag crystallization object distributing uniformly with a diameter 15 micrometers or less, and performing the aforementioned cold working by 99.997% or more of working -- super-thin -- it is the manufacture method of a conductor

[7] It is the manufacture method of a conductor. invention according to claim 3 performs cold working to the copper alloy ingot which the remainder becomes from Cu and an unescapable impurity, including Ag one to 4.5% -- super-thin -- the aforementioned ingot the dendrite arm space of a cast structure -- 15 micrometers or less and Ag crystallization object -- a diameter 15 micrometers or less -- uniform -- distributing -- the aforementioned cold working in the way -- the object for coils according to claim 1 characterized by being alike and annealing at the temperature under a recrystallizing temperature -- super-thin -- it is the manufacture method of a conductor

[8]

[Modiments of the Invention] as for this invention, the remainder consists of Cu and an unescapable impurity, including Ag one to 4.5% -- super-thin -- a conductor -- the path of the foreign matter contained inside was specified below to  $d_{mum}$ , and wire drawing nature and coil nature were raised -- super-thin -- it is a conductor However,  $d=0.63D+0.13$  (the inside of a formula and D are super-thin path mum of a conductor)

In this invention, Ag of an alloy element is super-thin, without distributing in the shape of a staple fiber, and reducing conductivity not much -- the intensity of a conductor is raised, with wire drawing nature and coil nature are improved less than 1%, the reason for specifying the content of Ag to 1 - 4.5% is because material cost becomes high, in conductivity's falling, if it is not fully improved but the aforementioned wire drawing nature and coil nature exceed 1%. 1.5 - 4% of especially the content of Ag is desirable.

[9] The convention of the aforementioned diameter of a foreign matter was made based on the next experiment. namely, by being made from the rough drawing wire (diameter of 8mm) of the Cu-2%Ag alloy manufactured by the R formula continuous casting machine, wire drawing of this was carried out to the conductor of the diameter of 100-micrometer, and the size of the foreign matter which remains in the fracture surface of the conductor disconnected at a time was measured with the scanning electron microscope (SEM). The path of a foreign matter is 13 micrometers more in the conductor of 63 micrometers or more and the diameter of 20 micrometer at the conductor of the diameter 100 micrometer, and and the diameter d of permission of the foreign matter in the conductor of Path D it is shown in Fig. 1 -- as --  $d=0.63D+0.13$  being expressed with (1) formula -- clear -- carrying out -- this -- based on (1) formula, for example, the diameter of 20 micrometer is super-thin -- in order to have carried out the wire drawing of the conductor by no disconnecting, it found out that what is necessary was just to set the diameter of a foreign matter to 12 micrometers or less By another experiment, when made from the extruded material of a large-sized ingot, the same result was obtained. Moreover, it was checked that the relation between an open circuit and the diameter of a foreign matter etc. is the same also in a tough pitch copper (TPC) or an oxygen free copper (OFC). the above super-thin in the relation of (1) formula -- the ratio of the cross section T of a conductor, and the cross section t of a foreign matter -- it needs to be shown in drawing 2 and super-thin, when expressed with a relation with wire drawing nature (the amount wire drawings until it results in an open circuit)  $t/T$  -- the area ratio (a foreign matter space factor is called hereafter) the foreign matter occupied to a conductor is super-thin -- a conductor -- when it is about 40% and a foreign matter

space factor exceeds 40% regardless of

[0010] When the aforementioned foreign matter was identified by the X-ray microanalyser (EPMA), they were mainly nonmetallic inclusions, such as oxide particles, such as aluminum  $2O_3$ ,  $SnO_2$ , and  $CuO$ , and a carbide ( $SiC$ ) particle. The aforementioned foreign matter is mixed from the alumina system or silica system refractory material which constitutes \*\* which connects the fusion furnace which mainly serves as a path until it results [ from the dissolution of a copper alloy molten metal ] in casting, a holding furnace, tundish, and these. In this invention, a foreign matter point out the aforementioned nonmetallic inclusion which influences an open circuit. In addition, although metal inclusion, such as Fe, Cr, and nickel, may mix from a processing fixture etc., these cannot cause easily an open circuit by most of the small thing whose path is about several micrometers. In the case of a flat-like foreign matter, in this invention, the shape of the shape of flat and an ellipse and the spherical of the configuration of a foreign matter are most, and in the case of the average of the maximum width and a total length over coupling faces, and an ellipse-like foreign matter, it is made as the average of a minor axis and a major axis, and the path of these foreign matters makes it an overall diameter, when spherical.

[0011] Although, as for the conductor which processed the ingot (material) cast in the large-sized facility, foreign matter open circuits occur frequently from per diameter of 100 micrometer, the ingot (material) which cast by performing the usual maintenance is processible by no disconnecting to the diameter of 30 micrometer using a small horizontal-type continuous casting facility. however, a path is [ around 20 micrometers ] super-thin -- in order to carry out the wire drawing of the conductor by no disconnecting, for that, a foreign matter keeps calm not only the usual maintenance but a molten metal for a long time by carrying out to below the diameter of 10 micrometer desirably below the diameter of 12 micrometer, a heavy foreign matter is made to sediment to a blast furnace bottom, a light foreign matter surfaces the surface of hot water, and the special molten metal treatment of casting a molten metal with few foreign matters of an interstitial segment is needed. If it does in this way, wire drawing will become possible to the diameter grade of 17 micrometer. Since invention of a claim 2 and three publications does not perform hot working or elevated-temperature annealing, there are few opportunities for the scale to mix as a foreign matter.

[0012] the object for coils to which the dendrite arm space (DAS) of a cast structure cold-works invention according to claim 2 at 99.997% or more of working ratio using the ingot which 15 micrometers or less and Ag crystallization object distributed uniformly with the diameter 15 micrometers or less -- super-thin -- it is the manufacture method of a conductor the reason DAS specifies the aforementioned ingot to the cast structure distributed uniformly [ 15 micrometers or less and Ag crystallization object ] in a diameter 15 micrometers or less -- the cold-working nature of an ingot -- improving -- moreover, a conductor -- it is for a surface concavo-convex defect to decrease and for pre-insulation nature to improve it is fully destroyed and the reason for specifying the working ratio of cold working to 99.997% or more has a super-thin cast structure -- Ag crystallization object distributed in an ingot is minutely distributed in the shape of a staple fiber -- the increase of the ductility of a conductor -- coiling -- a sex -- it is for improving

[0013] DAS becomes smaller [ a small ingot with a larger cooling rate ] depending on the cooling rate at the time of molten-metal solidification. That is, as shown in drawing 3, DAS is a vertical-mold continuous casting ingot. (200mmphi) SCR ingot (100x50mm) Small horizontal-type continuous casting machine ingot A (10mmphi) It becomes small in order. When the size of an ingot is the same, DAS is dependent on the temperature gradient of mold. That is, the case of the ingot of a small horizontal-type continuous casting machine, DAS of the ingot A which set [ cm ] up the temperature gradient of mold in 50 degrees C /is as large as 18 micrometers or more, and DAS of the ingot B which set [ cm ] up the temperature gradient of mold in 100 degrees C /is small at 15 micrometers or less. That is, DAS can obtain the ingot of the cast structure which 15 micrometers or less and Ag crystallization object distributed uniformly with the diameter 15 micrometers or less by enlarging the temperature gradient of mold and casting it using small mold.

[0014] cold working [ in / invention according to claim 2 / in invention according to claim 3 ] -- on the way -- the object for coils which was alike, put in annealing at the temperature of under a recrystallizing temperature, and raised total working ratio -- super-thin -- it is the manufacture method of a conductor. The effect by the aforementioned annealing is concretely explained with reference to drawing 4 below. In drawing 4, Curve a is the work-hardening property of the copper alloy cylindrical ingot of the diameter of 15mm which contains Ag 3%. Ductility falls and wire drawing becomes impossible while processing distortion epsilon shows the maximum intensity and carries out work softening of the curve a after that by 12. epsilon becomes a working limit by 13 (22 micrometers of wire sizes, 99.99978% of working ratio).

[0015] Curve b is a work-hardening property when epsilon anneals the material of Curve a at low temperature comparatively by the I point of 8.71. The maximum intensity of Curve b is of the same grade as the maximum intensity of Curve a, and epsilon at that time (epsilon 1) is increasing to 15 (5 micrometers of wire sizes, 99.999988% of

ing ratio). The aforementioned annealing was performed by passing the inside of the annealing furnace with a length of 2m which made the interior 700-degree C inert gas atmosphere between \*\* the speed for 200m/. the tensile strength after annealing -- 985N/mm2 it is -- this intensity is intensity by which epsilon (epsilon 2) of Curve a is equivalent to 6, and a distortion elimination factor is  $31\% = [(\epsilon_1 - \epsilon_2) / \epsilon_1 \times 100]$  The aforementioned tensile strength 985N/mm2 When it applies to the static annealing softening property of drawing 5, annealing between \*\* is equivalent to static annealing of 300 degree-Cx 1 hour, and is under a recrystallizing temperature. In addition, processing distortion epsilon of the material of Curve a of aforementioned drawing 5 is the static annealing softening property of the I point (wire-size 193micrometer, 99.98% of working ratio, tensile strength 1070N/mm2) of drawing 5. Thus, by putting in annealing at the temperature of under a recrystallizing temperature in the middle of cold drawing, high intensity can be maintained and total working ratio can be raised. Therefore, a more nearly super-thin conductor is obtained, or the diameter of a material (ingot) can be enlarged, and productivity improves. the conductor is put in annealing -- size (path) -- the wire drawing to the diameter of a target after annealing -- a conductor -- it is desirable to select so that intensity may turn into the highest intensity in front of a working limit Since the aforementioned annealing is performed at the low temperature of under a recrystallizing temperature, it is advantageous in energy. You may perform the aforementioned annealing repeatedly two or more times. Moreover, the direction formed with in-line is excellent in productivity rather than it carries out with outline. An effect with the same said of 1 annealing is acquired.

6] Curve c is a work-hardening property when epsilon (epsilon 1) anneals the material of Curve a at an elevated temperature (temperature more than a recrystallizing temperature) comparatively by the I point of 8.71. For the material of Curve c, epsilon is 16.5 (4 micrometers of wire sizes, 99.999993% of working ratio). It has disconnected and the tensile strength is quite [ material / of Curves a and b ] a low. The material of this curve c has [ that it is easy to connect intensity with an automatic winding machine for a low reason ] bad coiling nature. Although wire drawing of the material of this curve c was carried out several times using various wire drawing machines, each disconnected it after 4 micrometers. That is, 4 micrometers is a wire drawing limitation. Whatever the material, the conductor of a wire drawing limitation should avoid use. Annealing of the material of Curve c was performed by passing the inside of the annealing furnace with a length of 2m which made the interior 1000-degree C inert gas atmosphere between \*\* the speed for 150m/. the tensile strength after annealing -- 420N/mm2 it is -- this intensity is intensity by which epsilon (epsilon 2) of Curve a is equivalent to 0.1, and a distortion elimination factor is  $99\% = [(\epsilon_1 - \epsilon_2) / \epsilon_1 \times 100]$  The aforementioned tensile strength 420N/mm2 When it applies to drawing 5, annealing between \*\*\*\*\* is equivalent to static annealing of 500 degree-Cx 1 hour. It was checked that recrystallization is completed by microstructure observation.

7] Example] An example explains this invention in detail below.

Example 1) various carries out amount combination of Ag within this invention convention at electrolytic copper, this ingot got with a graphite crucible, it casts in metal mold to the ingot of the diameter of 10mm, and the diameter of 20 micrometer is super-thin in this ingot -- wire drawing (99.9996% of working ratio) was carried out to the conductor it obtained -- each -- super-thin -- the relation of tensile strength (TS), conductivity (EC), wire drawing nature, coil nature, and wire drawing nature and coil nature was investigated about the conductor similarly super-thin [ about the Ag alloy and oxygen free copper of composition this invention convention outside ] because of comparison -- the conductor was manufactured and the same investigation was conducted A result is shown in the drawing 6 (b) - a (e). The relation between tensile strength and Ag content was shown in the drawing 6 (b). The example article of this invention which contains Ag 1 to 4.5% is 2 940-1150Ns/mm. It turns out that it is high intensity. As for tensile strength, Ag falls rapidly at less than 1%. The relation between conductivity and Ag content was shown in the drawing 6 (c). It turns out that the example article of this invention which contains Ag 1 to 4.5% has the high conductivity of TS 88.5 to 81.5%. If Ag exceeds 4.5%, conductivity will fall under to a specification value (81.5%). The relation between the wire drawing nature (the amount of wire drawings per one open circuit) when carrying out a wire drawing is shown in drawing 6 (\*\*) from 25 micrometers at 20 micrometers and Ag content was shown. It turns out that the example article of this invention which contains Ag 1 to 4.5% has the high wire drawing nature of 1800 - 2500 g/Br. at less than 1%, the diameter of Ag of 20 micrometer is super-thin -- the wire drawing nature of 1800 g/Br required for the 24-hour continuation wire drawing of a conductor is not guaranteed The rapid fall of wire drawing nature whose Ag the improvement in the wire drawing nature in 1 - 3% is an effect by alloying, and exceeds 4.5% is based on the appearance of an eutectic structure. The relation between coil nature and Ag content was shown in the drawing 6 (d). The diameter of 20 micrometer of coil nature which carried out enamel covering is super-thin -- it expressed with the number of times of an open circuit when carrying out coiling of the conductor with a manual winding machine or an automatic winding machine, and producing the 100 magnetic heads There is [ in an automatic winding machine / in a



ual winding machine ] all little number of times of an open circuit of the example of this invention which contains 1 to 4.5% 4 or less times at 1 or less time. Especially desirable Ag content seen from coil nature is 1.5 - 4%. They wire drawing nature (the amount of wire drawings per one open circuit), and coil nature (number of times of an 1 circuit under 100 coil production) to the drawing 6 (\*\*). The relation was shown. The conductor which is excellent in wire drawing nature is excellent also in coil nature. this invention which consists of the drawing 6 (b) - a o a Cu-1 - 4.5%Ag alloy is super-thin -- a conductor -- the high conductivity more than 80%IACS -- it is -- 950-30N/mm<sup>2</sup> It has high intensity and it turns out that it moreover excels in wire drawing nature and coil nature.

8] (Example 2) wire drawing of the four following sorts of materials (Cu-2%Ag alloy) is carried out, and the meter of 25 micrometer is super-thin -- it considered as the conductor, the continuation wire drawing of this was carried out the speed for 400m/(67 g/hr) to the diameter of 20 micrometer, and total wire drawing time until it results in open circuit was investigated Moreover, the path of the foreign matter extracted in the foreign matter or acid solution process which remained in the fracture surface was measured by SEM observation. Both relation is shown in ving 7 . The continuation wire drawing of the three every bobbins each of the total wire drawing time was carried out and it measured continuation wire drawing time until the 1st open circuit occurs for every bobbin, and made the total total wire drawing time. For example, total wire drawing time when the 1st bobbin is disconnected 5 hours after, the 2nd bobbin is disconnected 3 hours after and the 3rd bobbin is disconnected 4 hours after was made into 12 hours. Since the wire drawing time of one bobbin (the 2500g of the maximum \*\*\*\*) is 37 hours, the greatest total wire drawing time is 111 hours. moreover, the aforementioned acid solution process is super-thin -- it is the method of dissolving 100g of conductors each from each five per one bobbin, and melting, filtering and extracting this in an acid Aerial is the following four sorts. \*\* the rough drawing wire of 8mmphi manufactured by the SCR method, the reduced material of 10mmphi manufactured by \*\* vertical-mold continuous casting and the extrusion method, and \*\* - the ingot of 10mmphi usually cast using the small horizontal-type continuous casting equipment of a maintenance, \*\* -- the ingot (example of this invention) of 10mmphi which cast the molten metal which removed the foreign matter enough using small horizontal-type continuous casting equipment in the special molten metal treatment From ving 7 , total wire drawing time becomes so long that a foreign matter is small, \*\* material 10 micrometers or less the longest diameter of a foreign matter, and, as for \*\* to which the diameter of a foreign matter exceeds 10 micrometers - \*\* material, wire drawing nature is short sharply. Although the aforementioned example explained the 2%Ag alloy, this invention is applied to a Cu-1 - 4.5%Ag alloy, and the same effect is acquired.

19] it rolled round in the bobbin (the diameter of 20 micrometer, the 2500g of the maximum \*\*\*\*) of the mentioned \*\* -- super-thin -- although coiling of the conductor (Cu-2%Ag alloy) was carried out with the automatic winding machine, the open circuit did not occur at all

20] it rolled round in the bobbin (the diameter of 20 micrometer, the 2500g of the maximum \*\*\*\*) of the mentioned \*\* -- super-thin -- the continuation wire drawing of the conductor was carried out to the diameter of 17 micrometer, the foreign matter was extracted by the acid solution process like the above-mentioned from the reduced-round bobbin, and the diameter of a foreign matter was measured by SEM observation Each diameter of a foreign matter was 10 micrometers or less.

21] (Example 3) 2% or the copper alloy included 4% is ingoted for Ag, and a foreign matter is sedimented or risen surface -- making -- the molten metal of an interstitial segment -- small horizontal-type continuous casting equipment -- the ingot of the diameter of 10mm -- continuous casting -- carrying out -- this -- 50-15 micrometers -- super-thin -- wire drawing was carried out to the conductor The temperature gradient of the mold in the aforementioned continuous casting was carried out [ cm ] in 100 degrees C /. The cast structure of the aforementioned ingot is detailed, S and Ag crystallization object are 15 micrometers or less, and Ag crystallization object was distributed uniformly. ingot which carried out [ cm ] the temperature gradient of mold in 50 degrees C /or less, and carried out continuous casting for comparison -- the same -- 50-15 micrometers -- super-thin -- wire drawing was carried out to the conductor s ingot had the comparatively coarse cast structure, and DAS and Ag crystallization object are 18 micrometers or more, and were distributing Ag crystallization object unevenly. it was obtained -- each -- super-thin -- wire drawing are (g/Br), tensile strength (TS), and conductivity (EC) were investigated about the conductor A result is shown in ble 1. In addition, wire drawing nature is a value when carrying out a continuation wire drawing to 190->50 micrometers, 50->32 micrometers, 32->25 micrometers, 25->20 micrometers, and 20->15 micrometers, respectively.

22]

ble 1]

| No. | 鋳塊からの冷間加工率% | x Cu-2%Ag<br>15 $\geq$ DAS, Ag晶出物 |            | y Cu-4%Ag<br>15 $\geq$ DAS, Ag晶出物 |            | z Cu-2%Ag<br>18 $\leq$ DAS,<br>Ag晶出物<br>伸線性 |
|-----|-------------|-----------------------------------|------------|-----------------------------------|------------|---|
|     |             | 伸線性                               | TS/EC      | 伸線性                               | TS/EC      |   |
| 1)  | 99.99750    | >5000                             | 1045/85.10 | >5000                             | 1095/82.35 | 4706  |
| 2)  | 99.99897    | >5000                             | 1075/85.06 | >5000                             | 1125/82.27 | 4451  |
| 3)  | 99.99937    | 3510                              | 1090/85.00 | 3360                              | 1140/82.15 | 1890  |
| 4)  | 99.99960    | 2450                              | 1095/84.96 | 2347                              | 1150/82.11 | 730   |
| 5)  | 99.99977    | 2275                              | 1105/84.85 | 2153                              | 1155/81.95 | 410   |

e) Wire drawing nature g/Br, TS(tensile strength)N/mm<sup>2</sup>, EC(conductivity) %IACS.

3] the cast structure was obtained from the detailed ingot so that more clearly than Table 1 -- super-thin -- conductor x and y were obtained from the ingot with the aforementioned comparatively coarse cast structure -- super -- a conductor -- wire drawing nature was superior to z In addition, the main causes that the wire drawing nature of rod at 25 micrometers or less are because casting conditions' being unsuitable and the external quality of a wire rod is bad. Although Ag was explained about 2% or the copper alloy included 4% above, also in Ag alloy, the same it is acquired Cu-1 to 4.5%.

4] (Example 4) the Cu-2%Ag alloy of the diameter of 20 micrometer manufactured in the example 3 -- the enamel covered to Conductor x and z and the high-pressure uniformity test estimated the insulating property A high-pressure uniformity test is an examination which impresses voltage between the enameled wire it runs, and an electrode and detects the poor insulation of an enameled wire by generating of a spark. The test condition was set to a part travel-speed/of 5m of an enameled wire, and applied-voltage 500V. The examination number made the enameled with a length of 30m 30. The insulating property was expressed with the average spark occurrences per one. A It is shown in Table 2.

5]  
Table 2]

| 膜厚さ | 6 $\mu$ m | 5 $\mu$ m | 4 $\mu$ m | 3 $\mu$ m | 2 $\mu$ m | ※鋳塊の鑄造組織 |
|-----|-----------|-----------|-----------|-----------|-----------|----------|
| 1のx | 0         | 0         | 0         | 0         | 0. 1      | 微細       |
| 1のz | 0         | 0. 0 3    | 0. 1      | 0. 7      | 1. 4      | 比較的粗い    |

te) For \*DAS and Ag crystallization object, 15 micrometers or less and Ag crystallization object are uniform distribution.

DAS and Ag crystallization object, 18 micrometers or more and Ag crystallization object are uneven distribution.

26] super-thin -- insulating effect with Conductor x sufficient by the patent leather film thickness of 3 micrometers acquired since this is a cast structure with the used detailed ingot -- a conductor -- it is because the surface

cavo-convex defect decreased super-thin -- a conductor -- since the used ingot was a comparatively coarse cast cture, z needed the patent leather film thickness of 6 micrometers or more to acquire sufficient insulating effect

27] the above -- super-thin -- it carried out 100 each at a time coiling of Conductor x and the enamel covered wire of the magnetic head for floppy disks with the automatic winding machine, and the number of times of an open circuit at time was investigated A result is shown in Table 3.

28]  
Table 3]

://www4.ipdl.jpo.go.jp/cgi-bin/tran\_web\_cgi\_ejje6

| け厚さ  | 6 $\mu$ m | 5 $\mu$ m | 4 $\mu$ m | 3 $\mu$ m | 2 $\mu$ m | ※鑄塊の鑄造組織 |
|------|-----------|-----------|-----------|-----------|-----------|----------|
| 表1のx | 0         | 0         | 0         | 0         | 0         | 微細       |
| 表1のz | 0         | 0         | 1         | 2         | 2         | 比較的粗い    |

(Note) For \*DAS and Ag crystallization object, 15 micrometers or less and Ag crystallization object are uniform distribution.

For DAS and Ag crystallization object, 18 micrometers or more and Ag crystallization object are uneven distribution [0029] super-thin so that more clearly than Table 3 -- although Conductor x was not disconnected, it is super-thin -- conductor -- the open circuit generated z in part DAS and Ag crystallization object are large and it is [ the distribution of Ag crystallization object of this is uneven, and ] super-thin again -- it is because the ductility of a conductor ran st

[0030] (Example 5) the work-hardening curve b of the copper alloy cylindrical ingot of the diameter of 15mm which contains Ag shown in drawing 4 3%, and the work-hardening curve c (example of comparison) are super-thin -- the tensile strength (TS) of a conductor (37-8.3 micrometers) was investigated moreover -- each -- super-thin -- the enan was covered to the conductor at 3-micrometer thickness, and the number of times of an open circuit when carrying o coiling of this enamel covered wire with an automatic winding machine was investigated A result is shown in Table [0031]

[Table 4]

| 導体径 $\mu$ m             |      | 3 7        | 2 2        | 1 4        | 8. 3       |
|-------------------------|------|------------|------------|------------|------------|
| 全加工歪 $\epsilon$         |      | 1 2. 0     | 1 3. 0     | 1 4. 0     | 1 5. 0     |
| 全減面率 %                  |      | 99. 999391 | 99. 999784 | 99. 999912 | 99. 999969 |
| TS<br>N/mm <sup>2</sup> | 曲線 b | 1 0 8 0    | 1 1 1 5    | 1 1 4 0    | 1 1 5 0    |
|                         | 曲線 c | 8 7 5      | 9 3 0      | 9 8 4      | 1 0 1 0    |
| コiling<br>時の断<br>線回数    | 曲線 b | 0          | 0          | 0          | 0          |
|                         | 曲線 c | 1          | 2          | 2          | 3          |

[0032] the example of this invention is super-thin so that more clearly than Table 4 -- the example of comparison of conductor (curve b) is super-thin -- a conductor (curve c) -- tensile strength -- which conductor -- also in the path, it was high the example of comparison is super-thin -- since tensile strength of a conductor was low, the open circuit produced it at the time of coiling in an automatic winding machine Although the copper alloy which contains Ag 3% above was explained, the same effect is acquired even if it applies to the other Cu-1 - 4.5%Ag alloy.

[0033]

[Effect of the Invention] it stated above -- as -- the object for the coils of this invention -- super-thin -- a conductor consists silver of a copper alloy of optimum dose \*\*\*\* high intensity, and since the path of the foreign matter more contained there is specified, it excels in wire drawing nature and coil nature the object for the coils of this invention super-thin -- a conductor can be easily manufactured by cold-working the ingot which specified crystallization \*\*\*\* DAS and Ag of a cast structure etc. by 99.997% or more of working ratio By putting in annealing at the temperature under a recrystallizing temperature in the middle of the aforementioned cold working, total working ratio can be enlarged and super-thin-izing of a conductor or enlargement of a material can be attained.

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#### TECHNICAL FIELD

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The technical field to which invention belongs] the object for coils which this invention is used for the coil of  
electronic equipment carried in the back light transformer of the vibrating motor for the stepping motor for clocks, the  
magnetic head of an audio video or a voice coil, a cellular phone, or pocket bells, various micro relays, a personal  
computer, or television or a flyback transformer, and an automobile, and is excellent in conductivity, a mechanical  
property, wire drawing nature, coil nature, etc. -- super-thin -- it is related with a conductor and its manufacture method

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## PRIOR ART

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Description of the Prior Art] the object for coils -- super-thin -- a conductor is orthopedically operated by the magnetic after enamel covering etc. Although the tough pitch copper (TPC), the oxygen free copper (OFC), etc. are used for material, it is easy to disconnect these material in wire drawing or coil processing for low strength. If an open circuit arises, a continuous wire drawing machine will be stopped, an open-circuit portion will be removed, the time and effort of setting a wire rod to a die and setting through and a die to a wire drawing machine is required, and productivity is injured. Moreover, if an open circuit arises, the defective by the shortage of a unit length will increase. However, if wire drawing is performed through day and night and it disconnects at the night of a perfect non-human system, a wire drawing machine will stop till the next morning, and productivity will fall sharply. Therefore, the wire conductor which is excellent in the wire drawing nature in which a continuation wire drawing is possible for 24 hours is demanded. a miniaturization and lightweight-izing of recent years and electronic equipment -- following -- 20 micrometers or less -- super-thin -- although a conductor came to be required, incidentally, the amount of wire savings when carrying out the continuation wire drawing of the conductor of the diameter of 20 micrometer the speed 100m/for 24 hours is 1610g, and when the safety factor is taken to 10%, the wire drawing nature of 1800 g/Br is needed furthermore, a path is about 20 micrometers -- super-thin -- since a conductor fractures by the tension of several times it disconnects by delicate change of a backward tension in an automatic winding machine In a manual winding machine, operation takes skill and there is a problem that it is inferior to productivity again.

[3] the object for coils since it is such -- super-thin -- the Cu-Ag system alloy which is excellent in intensity and productivity as a conductor -- a close-up of a conductor was taken and the proposal of the following \*\* - \*\* was made. However, in order that all may multiple-times need elevated-temperature annealing, including expensive Ag, such, there is a problem in respect of cost and productivity. namely, the object for coils which prevented the open circuit by the lubrication action of Ag which carries out pickling removal of the copper alternatively from the wire rod surface of the copper alloy which contains \*\*Ag 5 to 15%, raises surface Ag concentration, performs repair of a surface blemish, and covering of a foreign matter by Enrichment Ag, and is further rich in ductility -- super-thin -- a conductor (JP,7-96321,A) \*\* the object for high magnetic field generating for magnets which made the copper alloy which contains Ag 15 to 30% the cylindrical ingot of a minor diameter by the continuous casting process, and skipped the process of hot forging and facing -- a conductor (JP,6-93398,A, JP,6-93399,A, JP,6-103809,A) \*\* The path which the copper alloy ingot which contains Ag 15 to 30% was processed at 95% or more of working ratio, and it annealed [ path ], it cold-worked [ path ] at the temperature more than a recrystallizing temperature after that, and recovered its elongation and conductivity is the conductor (JP,6-93398,A) of 0.1 or more mm. \*\* The conductor about [ of having elongation in annealing at the temperature more than a recrystallizing temperature, having cold-worked the copper alloy ingot which contains Ag 15 to 30%, and having recovered conductivity ] the diameter of 0.9mm (JP,6-93399,A). \*\* The conductor of the diameter of 0.1mm which processed the copper alloy ingot which contains Ag 15 to 30% by 95% or more of working ratio, and annealed and cold-worked at the temperature more than a recrystallizing temperature after that (JP,6-103809,A). \*\* the metal mold of the copper alloy which contains Ag two to 2.8% -- the object for the marine cables of the diameter of 0.65mm which solution treatment of the ingot was carried out, the multiple-times of the aging treatment was carried out to wire drawing after that, and intensity was raised, and omitted the reinforcement iron braid of a cable -- a conductor (JP,48-44798,A)

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EFFECT OF THE INVENTION

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[Effect of the Invention] it stated above -- as -- the object for the coils of this invention -- super-thin -- a conductor consists of silver or a copper alloy of proper quantity \*\*\*\* high intensity, and since the path of the foreign matter is never contained there is specified, it excels in wire drawing nature and coil nature the object for the coils of this invention -- super-thin -- a conductor can be easily manufactured by cold-working the ingot which specified crystallization \*\*\*\* of DAS and Ag of a cast structure etc. by 99.997% or more of working ratio By putting in working at the temperature of under a recrystallizing temperature in the middle of the aforementioned cold working, working ratio can be enlarged and super-thin-izing of a conductor or enlargement of a material can be attained.

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#### TECHNICAL PROBLEM

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Problem(s) to be Solved by the Invention] Then, this invention person etc. inquired wholeheartedly about application of the coil of the copper alloy containing Ag, clarified the addition of Ag suitable for wire drawing nature and coil nature, advances research about the tolerance limit of the cast structure which is further excellent in wire drawing nature and coil nature, and foreign matter size etc., and came to complete this invention. the object for coils this invention excels [ object ] in conductivity, tensile strength, wire drawing nature, coil nature, etc. -- super-thin -- it aims for of a conductor and its manufacture method

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TRANS

[Means for Solving the Problem] as for invention according to claim 1, the remainder consists of Cu and an unescapable impurity, including Ag one to 4.5% of the weight (it is hereafter written as %) -- super-thin -- a conductor -- the above -- super-thin -- a conductor -- the object for coils characterized by the path of the foreign matter contained inside being below  $d_{\text{mum}}$  -- super-thin -- it is a conductor However,  $d=0.63D+0.13$  (the inside of a formula and D are super-thin path mum of a conductor)

6] It is the manufacture method of a conductor. invention according to claim 2 performs cold working to the alloy ingot which the remainder becomes from Cu and an unescapable impurity, including Ag one to 4.5% -- super-thin -- the aforementioned ingot the object for coils according to claim 1 to which the dendrite arm space of a structure is characterized by for 15 micrometers or less and Ag crystallization object distributing uniformly with a diameter 15 micrometers or less, and performing the aforementioned cold working by 99.997% or more of working -- super-thin -- it is the manufacture method of a conductor

7] It is the manufacture method of a conductor. invention according to claim 3 performs cold working to the alloy ingot which the remainder becomes from Cu and an unescapable impurity, including Ag one to 4.5% -- super-thin -- the aforementioned ingot the dendrite arm space of a cast structure -- 15 micrometers or less and Ag crystallization object -- a diameter 15 micrometers or less -- uniform -- distributing -- the aforementioned cold working the way -- the object for coils according to claim 1 characterized by being alike and annealing at the temperature under a recrystallizing temperature -- super-thin -- it is the manufacture method of a conductor

8] [Advantages of the Invention] as for this invention, the remainder consists of Cu and an unescapable impurity, including Ag one to 4.5% -- super-thin -- a conductor -- the path of the foreign matter contained inside was specified with  $d_{\text{mum}}$ , and wire drawing nature and coil nature were raised -- super-thin -- it is a conductor However,  $d=0.63D+0.13$  (the inside of a formula and D are super-thin path mum of a conductor)

In this invention, Ag of an alloy element is super-thin, without distributing in the shape of a staple fiber, and reducing ductility not much -- the intensity of a conductor is raised, with wire drawing nature and coil nature are improved less than 1%, the reason for specifying the content of Ag to 1 - 4.5% is because material cost becomes high, in ductility's falling, if it is not fully improved but the aforementioned wire drawing nature and coil nature exceed 6. 1.5 - 4% of especially the content of Ag is desirable.

9] The convention of the aforementioned diameter of a foreign matter was made based on the next experiment. Namely, by being made from the rough drawing wire (diameter of 8mm) of the Cu-2%Ag alloy manufactured by the formula continuous casting machine, wire drawing of this was carried out to the conductor of the diameter of 100-micrometer, and the size of the foreign matter which remains in the fracture surface of the conductor disconnected at time was measured with the scanning electron microscope (SEM). The path of a foreign matter is 13 micrometers more in the conductor of 63 micrometers or more and the diameter of 20 micrometer at the conductor of the diameter 100 micrometer, and and the diameter d of permission of the foreign matter in the conductor of Path D it is shown in Figure 1 -- as --  $d=0.63D+0.13$  being expressed with (1) formula -- clear -- carrying out -- this -- based on (1) formula, for example, the diameter of 20 micrometer is super-thin -- in order to have carried out the wire drawing of the conductor by no disconnecting, it found out that what is necessary was just to set the diameter of a foreign matter to 12 micrometers or less By another experiment, when made from the extruded material of a large-sized ingot, the same was obtained. Moreover, it was checked that the relation between an open circuit and the diameter of a foreign matter etc. is the same also in a tough pitch copper (TPC) or an oxygen free copper (OFC). the above super-thin in the relation of (1) formula -- the ratio of the cross section T of a conductor, and the cross section t of a foreign matter -- it has to be shown in drawing 2 and super-thin, when expressed with a relation with wire drawing nature (the amount of wire drawings until it results in an open circuit)  $t/T$  -- the area ratio (a foreign matter space factor is called hereafter)

ie foreign matter occupied to a conductor is super-thin -- a conductor -- when it is about 40% and a foreign matter factor exceeds 40% regardless of

[0] When the aforementioned foreign matter was identified by the X-ray microanalyser (EPMA), they were mainly metallic inclusions, such as oxide particles, such as aluminum  $2O_3$ ,  $SnO_2$ , and  $CuO$ , and a carbide ( $SiC$ ) particle. The aforementioned foreign matter is mixed from the alumina system or silica system refractory material which constitutes \*\* which connects the fusion furnace which mainly serves as a path until it results [ from the dissolution of copper alloy molten metal ] in casting, a holding furnace, tundish, and these. In this invention, a foreign matter points to the aforementioned nonmetallic inclusion which influences an open circuit. In addition, although metal inclusion, such as Fe, Cr, and nickel, may mix from a processing fixture etc., these cannot cause easily an open circuit by most of small thing whose path is about several micrometers. In the case of a flat-like foreign matter, in this invention, the shape of the shape of flat and an ellipse and the spherical of the configuration of a foreign matter are most, and in the case of the average of the maximum width and a total length over coupling faces, and an ellipse-like foreign matter, it is made as the average of a minor axis and a major axis, and the path of these foreign matters makes it an overall diameter, when spherical.

[1] Although, as for the conductor which processed the ingot (material) cast in the large-sized facility, foreign matter open circuits occur frequently from per diameter of 100 micrometer, the ingot (material) which cast by forming the usual maintenance is processible by no disconnecting to the diameter of 30 micrometer using a small horizontal-type continuous casting facility. however, a path is [ around 20 micrometers ] super-thin -- in order to carry out the wire drawing of the conductor by no disconnecting, for that, a foreign matter keeps calm not only the usual maintenance but a molten metal for a long time by carrying out to below the diameter of 10 micrometer desirably. Now the diameter of 12 micrometer, a heavy foreign matter is made to sediment to a blast furnace bottom, a light foreign matter surfaces the surface of hot water, and the special molten metal treatment of casting a molten metal with foreign matters of an interstitial segment is needed. If it does in this way, wire drawing will become possible to the meter grade of 17 micrometer. Since invention of a claim 2 and three publications does not perform hot working or heat-treated-temperature annealing, there are few opportunities for the scale to mix as a foreign matter.

[2] the object for coils to which the dendrite arm space (DAS) of a cast structure cold-works invention according to claim 2 at 99.997% or more of working ratio using the ingot which 15 micrometers or less and Ag crystallization object distributed uniformly with the diameter 15 micrometers or less -- super-thin -- it is the manufacture method of a conductor the reason DAS specifies the aforementioned ingot to the cast structure distributed uniformly [ 15 micrometers or less and Ag crystallization object ] in a diameter 15 micrometers or less -- the cold-working nature of ingot -- improving -- moreover, a conductor -- it is for a surface concavo-convex defect to decrease and for pre-oxidation nature to improve it is fully destroyed and the reason for specifying the working ratio of cold working to 99.997% or more has a super-thin cast structure -- Ag crystallization object distributed in an ingot is minutely distributed in the shape of a staple fiber -- the increase of the ductility of a conductor -- coiling -- a sex -- it is for improving

[3] DAS becomes smaller [ a small ingot with a larger cooling rate ] depending on the cooling rate at the time of ten-metal solidification. That is, as shown in drawing 3, DAS is a vertical-mold continuous casting ingot. 10mmphi) SCR ingot (100x50mm) Small horizontal-type continuous casting machine ingot A (10mmphi) It becomes small in order. When the size of an ingot is the same, DAS is dependent on the temperature gradient of mold. That is, in the case of the ingot of a small horizontal-type continuous casting machine, DAS of the ingot A which set [ cm ] up the temperature gradient of mold in 50 degrees C /is as large as 18 micrometers or more, and DAS of the ingot B which set [ cm ] up the temperature gradient of mold in 100 degrees C /is small at 15 micrometers or less. That is, DAS can obtain the ingot of the cast structure which 15 micrometers or less and Ag crystallization object distributed uniformly with the diameter 15 micrometers or less by enlarging the temperature gradient of mold and casting it using small mold.

[4] cold working [ in / invention according to claim 2 / in invention according to claim 3 ] -- on the way -- the effect for coils which was alike, put in annealing at the temperature of under a recrystallizing temperature, and raised cold working ratio -- super-thin -- it is the manufacture method of a conductor The effect by the aforementioned annealing is concretely explained with reference to drawing 4 below. In drawing 4, Curve a is the work-hardening property of the copper alloy cylindrical ingot of the diameter of 15mm which contains Ag 3%. Ductility falls and wire drawing becomes impossible while processing distortion epsilon shows the maximum intensity and carries out work hardening of the curve a after that by 12. epsilon becomes a working limit by 13 (22 micrometers of wire sizes, 99.9978% of working ratio).

[5] Curve b is a work-hardening property when epsilon anneals the material of Curve a at low temperature comparatively by the I point of 8.71. The maximum intensity of Curve b is of the same grade as the maximum intensity

Curve a, and epsilon at that time (epsilon 1) is increasing to 15 (5 micrometers of wire sizes, 99.999988% of working ratio). The aforementioned annealing was performed by passing the inside of the annealing furnace with a length of 2m which made the interior 700-degree C inert gas atmosphere between \*\* the speed for 200m/. the tensile strength after annealing -- 985N/mm2 it is -- this intensity is intensity by which epsilon (epsilon 2) of Curve a is equivalent to 6, and a distortion elimination factor is  $31\% = \frac{(\epsilon_1 - \epsilon_2)}{\epsilon_1} \times 100$  The aforementioned tensile strength 985N/mm2 When it applies to the static annealing softening property of drawing 5, annealing between \*\* is equivalent to static annealing of 300 degree-C x 1 hour, and is under a recrystallizing temperature. In addition, processing distortion epsilon of the material of Curve a of aforementioned drawing 5 is the static annealing softening property of the I point (wire-size 193micrometer, 99.98% of working ratio, tensile strength 1070N/mm2) of Curve a. Thus, by putting in annealing at the temperature of under a recrystallizing temperature in the middle of cold drawing, high intensity can be maintained and total working ratio can be raised. Therefore, a more nearly super-thin conductor is obtained, or the diameter of a material (ingot) can be enlarged, and productivity improves. the conductor puts in annealing -- size (path) -- the wire drawing to the diameter of a target after annealing -- a conductor -- it is desirable to select so that intensity may turn into the highest intensity in front of a working limit Since the aforementioned annealing is performed at the low temperature of under a recrystallizing temperature, it is advantageous for energy. You may perform the aforementioned annealing repeatedly two or more times. Moreover, the direction formed with in-line is excellent in productivity rather than it carries out with outline. An effect with the same said of annealing is acquired.

5] Curve c is a work-hardening property when epsilon (epsilon 1) anneals the material of Curve a at an elevated temperature (temperature more than a recrystallizing temperature) comparatively by the I point of 8.71. For the material of Curve c, epsilon is 16.5 (4 micrometers of wire sizes, 99.999993% of working ratio). It has disconnected and the tensile strength is quite [ material / of Curves a and b ] a low. The material of this curve c has [ that it is easy to connect intensity with an automatic winding machine for a low reason ] bad coiling nature. Although wire drawing of the material of this curve c was carried out several times using various wire drawing machines, each disconnected it after 4 micrometers. That is, 4 micrometers is a wire drawing limitation. Whatever the material, the conductor of a wire drawing limitation should avoid use. Annealing of the material of Curve c was performed by passing the inside of the annealing furnace with a length of 2m which made the interior 1000-degree C inert gas atmosphere between \*\* the speed for 150m/. the tensile strength after annealing -- 420N/mm2 it is -- this intensity is intensity by which epsilon (epsilon 2) of Curve a is equivalent to 0.1, and a distortion elimination factor is  $99\% = \frac{(\epsilon_1 - \epsilon_2)}{\epsilon_1} \times 100$  The aforementioned tensile strength 420N/mm2 When it applies to drawing 5, annealing between \*\*\*\*\* is equivalent to static annealing of 500 degree-C x 1 hour. It was checked that recrystallization is completed by microstructure observation.

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## MPLE

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mple] An example explains this invention in detail below.

mple 1) various carries out amount combination of Ag within this invention convention at electrolytic copper, this  
goted with a graphite crucible, it casts in metal mold to the ingot of the diameter of 10mm, and the diameter of 20  
ometer is super-thin in this ingot -- wire drawing (99.9996% of working ratio) was carried out to the conductor it  
obtained -- each -- super-thin -- the relation of tensile strength (TS), conductivity (EC), wire drawing nature, coil  
re, and wire drawing nature and coil nature was investigated about the conductor similarly super-thin [ about the  
Ag alloy and oxygen free copper of composition this invention convention outside ] because of comparison -- the  
luctor was manufactured and the same investigation was conducted A result is shown in the drawing 6 (b) - a (e).  
relation between tensile strength and Ag content was shown in the drawing 6 (b). The example article of this  
ntion which contains Ag 1 to 4.5% is 2 940-1150Ns/mm. It turns out that it is high intensity. As for tensile  
gth, Ag falls rapidly at less than 1%. The relation between conductivity and Ag content was shown in the drawing  
) . It turns out that the example article of this invention which contains Ag 1 to 4.5% has the high conductivity of  
S 88.5 to 81.5%. If Ag exceeds 4.5%, conductivity will fall under to a specification value (81.5%). The relation  
ween the wire drawing nature (the amount of wire drawings per one open circuit) when carrying out a wire drawing  
e drawing 6 (\*\*) from 25 micrometers at 20 micrometers and Ag content was shown. It turns out that the example  
le of this invention which contains Ag 1 to 4.5% has the high wire drawing nature of 1800 - 2500 g/Br. at less than  
the diameter of Ag of 20 micrometer is super-thin -- the wire drawing nature of 1800 g/Br required for the 24-hour  
inuation wire drawing of a conductor is not guaranteed The rapid fall of wire drawing nature whose Ag the  
ovement in the wire drawing nature in 1 - 3% is an effect by alloying, and exceeds 4.5% is based on the  
earance of an eutectic structure. The relation between coil nature and Ag content was shown in the drawing 6 (d).  
diameter of 20 micrometer of coil nature which carried out enamel covering is super-thin -- it expressed with the  
ber of times of an open circuit when carrying out coiling of the conductor with a manual winding machine or an  
omatic winding machine, and producing the 100 magnetic heads There is [ in an automatic winding machine / in a  
ual winding machine ] all little number of times of an open circuit of the example of this invention which contains  
1 to 4.5% 4 or less times at 1 or less time. Especially desirable Ag content seen from coil nature is 1.5 - 4%. They  
wire drawing nature (the amount of wire drawings per one open circuit), and coil nature (number of times of an  
n circuit under 100 coil production) to the drawing 6 (\*\*). The relation was shown. The conductor which is  
ellent in wire drawing nature is excellent also in coil nature. this invention which consists of the drawing 6 (b) - a  
o a Cu-1 - 4.5%Ag alloy is super-thin -- a conductor -- the high conductivity more than 80%IACS -- it is -- 950-  
0N/mm<sup>2</sup> It has high intensity and it turns out that it moreover excels in wire drawing nature and coil nature.  
18] (Example 2) wire drawing of the four following sorts of materials (Cu-2%Ag alloy) is carried out, and the  
neter of 25 micrometer is super-thin -- it considered as the conductor, the continuation wire drawing of this was  
ied out the speed for 400m/(67 g/hr) to the diameter of 20 micrometer, and total wire drawing time until it results in  
open circuit was investigated Moreover, the path of the foreign matter extracted in the foreign matter or acid  
ition process which remained in the fracture surface was measured by SEM observation. Both relation is shown in  
wing 7 . The continuation wire drawing of the three every bobbins each of the total wire drawing time was carried  
and it measured continuation wire drawing time until the 1st open circuit occurs for every bobbin, and made the  
total total wire drawing time. For example, total wire drawing time when the 1st bobbin is disconnected 5 hours  
r, the 2nd bobbin is disconnected 3 hours after and the 3rd bobbin is disconnected 4 hours after was made into 12  
rs. Since the wire drawing time of one bobbin (the 2500g of the maximum \*\*\*\*) is 37 hours, the greatest total wire  
wing time is 111 hours. moreover, the aforementioned acid solution process is super-thin -- it is the method of  
ipling 100g of conductors each from each five per one bobbin, and melting, filtering and extracting this in an acid A  
erial is the following four sorts. \*\* the rough drawing wire of 8mmphi manufactured by the SCR method, the

extruded material of 10mmphi manufactured by \*\* vertical-mold continuous casting and the extrusion method, and \* - the ingot of 10mmphi usually cast using the small horizontal-type continuous casting equipment of a maintenance, and \*\* - the ingot (example of this invention) of 10mmphi which cast the molten metal which removed the foreign matter enough using small horizontal-type continuous casting equipment in the special molten metal treatment From drawing 7 , total wire drawing time becomes so long that a foreign matter is small, \*\* material 10 micrometers or less has the longest diameter of a foreign matter, and, as for \*\* to which the diameter of a foreign matter exceeds 10 micrometers - \*\* material, wire drawing nature is short sharply. Although the aforementioned example explained the Cu-2%Ag alloy, this invention is applied to a Cu-1 - 4.5%Ag alloy, and the same effect is acquired.

[0019] it rolled round in the bobbin (the diameter of 20 micrometer, the 2500g of the maximum \*\*\*\*) of the aforementioned \*\* -- super-thin -- although coiling of the conductor (Cu-2%Ag alloy) was carried out with the automatic winding machine, the open circuit did not occur at all

[0020] it rolled round in the bobbin (the diameter of 20 micrometer, the 2500g of the maximum \*\*\*\*) of the aforementioned \*\* -- super-thin -- the continuation wire drawing of the conductor was carried out to the diameter of 1 more micrometer, the foreign matter was extracted by the acid solution process like the above-mentioned from the rolled-round bobbin, and the diameter of a foreign matter was measured by SEM observation Each diameter of a foreign matter was 10 micrometers or less.

[0021] (Example 3) 2% or the copper alloy included 4% is ingoted for Ag, and a foreign matter is sedimented or risen to surface -- making -- the molten metal of an interstitial segment -- small horizontal-type continuous casting equipment -- the ingot of the diameter of 10mm -- continuous casting -- carrying out -- this -- 50-15 micrometers -- super-thin -- wire drawing was carried out to the conductor The temperature gradient of the mold in the aforementioned continuous casting was carried out [ cm ] in 100 degrees C /. The cast structure of the aforementioned ingot is detailed DAS and Ag crystallization object are 15 micrometers or less, and Ag crystallization object was distributed uniformly the ingot which carried out [ cm ] the temperature gradient of mold in 50 degrees C /or less, and carried out continuous casting for comparison -- the same -- 50-15 micrometers -- super-thin -- wire drawing was carried out to the conductor This ingot had the comparatively coarse cast structure, and DAS and Ag crystallization object are 18 micrometers or more, and were distributing Ag crystallization object unevenly. it was obtained -- each -- super-thin -- wire drawing nature (g/Br), tensile strength (TS), and conductivity (EC) were investigated about the conductor A result is shown in Table 1. In addition, wire drawing nature is a value when carrying out a continuation wire drawing to 190->50 micrometers, 50->32 micrometers, 32->25 micrometers, 25->20 micrometers, and 20->15 micrometers, respectively.

[0022]

[Table 1]

| 導体<br>径<br><br>μm | 鋳塊から<br>の冷間<br>加工率% | x Cu-2%Ag<br>15≥DAS, Ag晶出物 |            | y Cu-4%Ag<br>15≥DAS, Ag晶出物 |            | z Cu-2%Ag<br>18≥DAS,<br>Ag晶出物<br>伸線性 |
|-------------------|---------------------|----------------------------|------------|----------------------------|------------|--------------------------------------|
|                   |                     | 伸線性                        | TS/EC      | 伸線性                        | TS/EC      |                                      |
| 5 0               | 99.99750            | >5000                      | 1045/85.10 | >5000                      | 1095/82.35 | 4706                                 |
| 3 2               | 99.99897            | >5000                      | 1075/85.06 | >5000                      | 1125/82.27 | 4451                                 |
| 2 5               | 99.99937            | 3510                       | 1090/85.00 | 3360                       | 1140/82.15 | 1890                                 |
| 2 0               | 99.99960            | 2450                       | 1095/84.96 | 2347                       | 1150/82.11 | 730                                  |
| 1 5               | 99.99977            | 2275                       | 1105/84.85 | 2153                       | 1155/81.95 | 410                                  |

(Note) Wire drawing nature g/Br, TS(tensile strength)N/mm2, EC(conductivity) %IACS.

[0023] the cast structure was obtained from the detailed ingot so that more clearly than Table 1 -- super-thin -- Conductor x and y were obtained from the ingot with the aforementioned comparatively coarse cast structure -- super-thin -- a conductor -- wire drawing nature was superior to z In addition, the main causes that the wire drawing nature z is bad at 25 micrometers or less are because casting conditions' being unsuitable and the external quality of a wire r

bad. Although Ag was explained about 2% or the copper alloy included 4% above, also in Ag alloy, the same is acquired Cu-1 to 4.5%.

4] (Example 4) the Cu-2%Ag alloy of the diameter of 20 micrometer manufactured in the example 3 -- the enamel covered to Conductor x and z and the high-pressure uniformity test estimated the insulating property A high-pressure uniformity test is an examination which impresses voltage between the enameled wire it runs, and an electrode and detects the poor insulation of an enameled wire by generating of a spark. The test condition was set to a part travel-speed/of 5m of an enameled wire, and applied-voltage 500V. The examination number made the enameled with a length of 30m 30. The insulating property was expressed with the average spark occurrences per one. A result is shown in Table 2.

5]  
Table 2]

| 厚さ  | 6 $\mu$ m | 5 $\mu$ m | 4 $\mu$ m | 3 $\mu$ m | 2 $\mu$ m | ※鋳塊の鑄造組織 |
|-----|-----------|-----------|-----------|-----------|-----------|----------|
| 1のx | 0         | 0         | 0         | 0         | 0. 1      | 微細       |
| 1のz | 0         | 0. 0 3    | 0. 1      | 0. 7      | 1. 4      | 比較的粗い    |

e) For \*DAS and Ag crystallization object, 15 micrometers or less and Ag crystallization object are uniform distribution.

DAS and Ag crystallization object, 18 micrometers or more and Ag crystallization object are uneven distribution.

6] super-thin -- insulating effect with Conductor x sufficient by the patent leather film thickness of 3 micrometers acquired since this is a cast structure with the used detailed ingot -- a conductor -- it is because the surface concavo-convex defect decreased super-thin -- a conductor -- since the used ingot was a comparatively coarse cast structure, z needed the patent leather film thickness of 6 micrometers or more to acquire sufficient insulating effect 7] the above -- super-thin -- it carried out 100 each at a time coiling of Conductor x and the enamel covered wire of the magnetic head for floppy disks with the automatic winding machine, and the number of times of an open circuit at time was investigated A result is shown in Table 3.

8]  
Table 3]

| 厚さ  | 6 $\mu$ m | 5 $\mu$ m | 4 $\mu$ m | 3 $\mu$ m | 2 $\mu$ m | ※鋳塊の鑄造組織 |
|-----|-----------|-----------|-----------|-----------|-----------|----------|
| 1のx | 0         | 0         | 0         | 0         | 0         | 微細       |
| 1のz | 0         | 0         | 1         | 2         | 2         | 比較的粗い    |

te) For \*DAS and Ag crystallization object, 15 micrometers or less and Ag crystallization object are uniform distribution.

DAS and Ag crystallization object, 18 micrometers or more and Ag crystallization object are uneven distribution.

29] super-thin so that more clearly than Table 3 -- although Conductor x was not disconnected, it is super-thin -- a conductor -- the open circuit generated z in part DAS and Ag crystallization object are large and it is [ the distribution of Ag crystallization object of this is uneven, and ] super-thin again -- it is because the ductility of a conductor ran short

30] (Example 5) the work-hardening curve b of the copper alloy cylindrical ingot of the diameter of 15mm which contains Ag shown in drawing 4 3%, and the work-hardening curve c (example of comparison) are super-thin -- the tensile strength (TS) of a conductor (37-8.3 micrometers) was investigated moreover -- each -- super-thin -- the enamel is covered to the conductor at 3-micrometer thickness, and the number of times of an open circuit when carrying out coiling of this enamel covered wire with an automatic winding machine was investigated A result is shown in Table 4.

31]  
Table 4]

|                         |               |           |           |           |           |
|-------------------------|---------------|-----------|-----------|-----------|-----------|
| 導体径                     | $\mu\text{m}$ | 37        | 22        | 14        | 8.3       |
| 全加工歪                    | $\varepsilon$ | 12.0      | 13.0      | 14.0      | 15.0      |
| 全減面率                    | %             | 99.999391 | 99.999784 | 99.999912 | 99.999969 |
| TS<br>N/mm <sup>2</sup> | 曲線b           | 1080      | 1115      | 1140      | 1150      |
|                         | 曲線c           | 875       | 930       | 984       | 1010      |
| コiling<br>時の断<br>線回数    | 曲線b           | 0         | 0         | 0         | 0         |
|                         | 曲線c           | 1         | 2         | 2         | 3         |

[0032] the example of this invention is super-thin so that more clearly than Table 4 -- the example of comparison of a conductor (curve b) is super-thin -- a conductor (curve c) -- tensile strength -- which conductor -- also in the path, it was high the example of comparison is super-thin -- for the low reason, the open circuit produced [ tensile strength ] conductor at the time of coiling in an automatic winding machine Although the copper alloy which contains Ag 3% above was explained, the same effect is acquired even if it applies to the other Cu-1 - 4.5%Ag alloy.

[Translation done.]

## NOTICES \*

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## DESCRIPTION OF DRAWINGS

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[Brief Description of the Drawings]

Figure 1] the diameter of a foreign matter about wire drawing nature, and a conductor -- it is drawing showing the relation of a path

Figure 2] It is drawing showing the relation between wire drawing nature and a foreign matter space factor.

Figure 3] It is drawing showing the relation between DAS and the diameter of an ingot.

Figure 4] It is drawing showing the relation between tensile strength and processing distortion (work-hardening property).

Figure 5] It is drawing showing the relation between tensile strength and an annealing temperature (annealing property).

Figure 6] the object for the coils of this invention -- super-thin -- Ag content in a conductor, and tensile strength A and conductivity A (b) and wire drawing nature A (c) and coil nature A relation with a (d), and relation between drawing nature and coil nature a (e) is shown -- it is each explanatory drawing

Figure 7] the diameter of 20 micrometer is super-thin -- it is drawing showing the relation of the wire drawing nature and the diameter of a foreign matter in a conductor

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[Translation done.]



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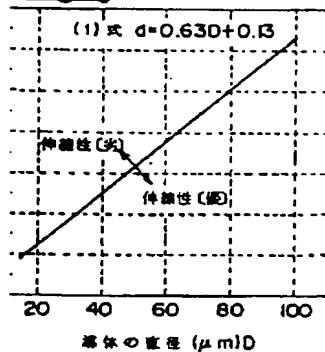
This document has been translated by computer. So the translation may not reflect the original precisely.

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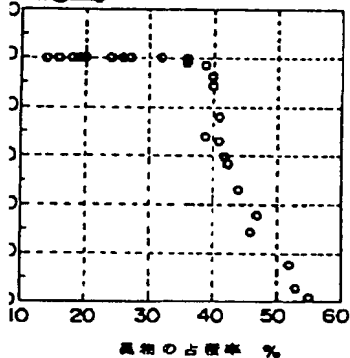
In the drawings, any words are not translated.

## WINGS

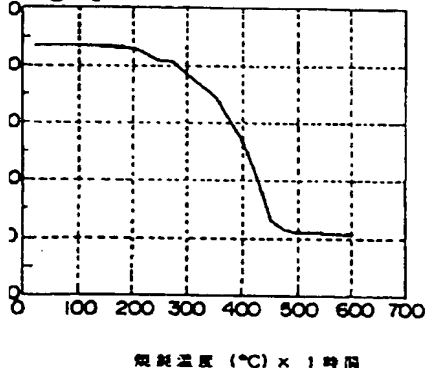
wing 1]



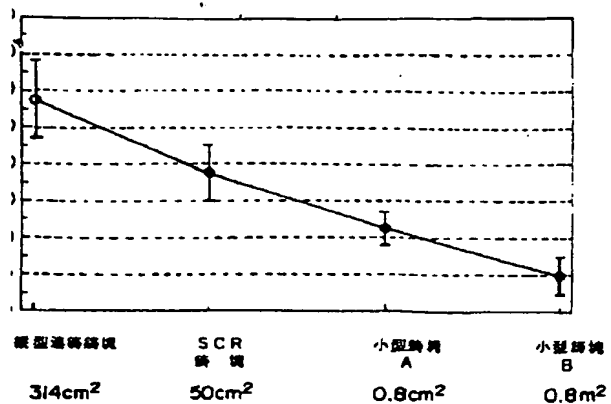
wing 2]



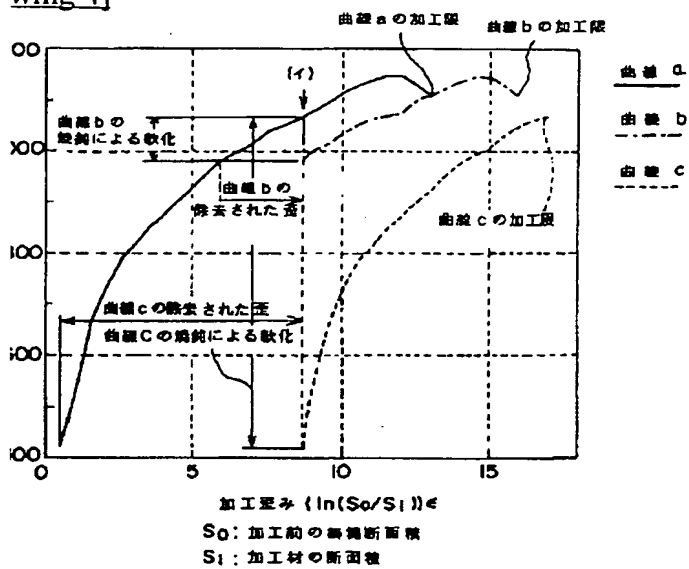
wing 5]



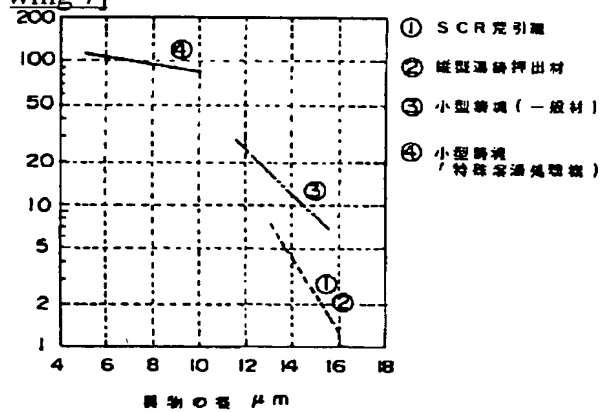
wing 3]



wing 4]

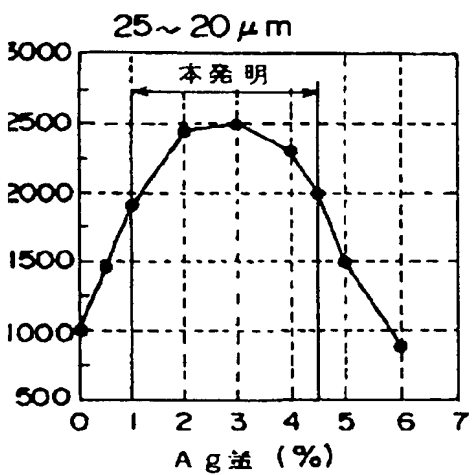
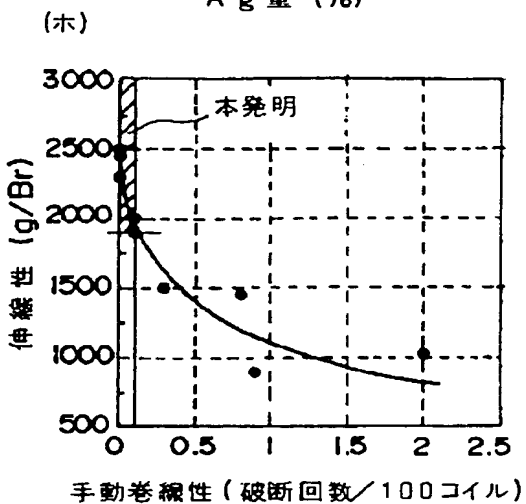
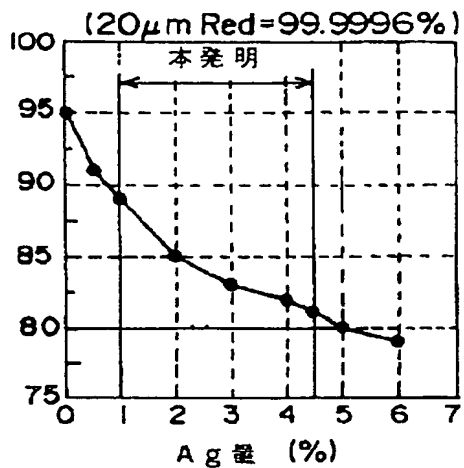
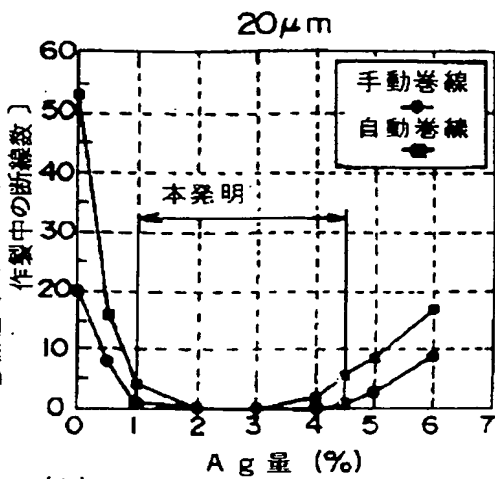
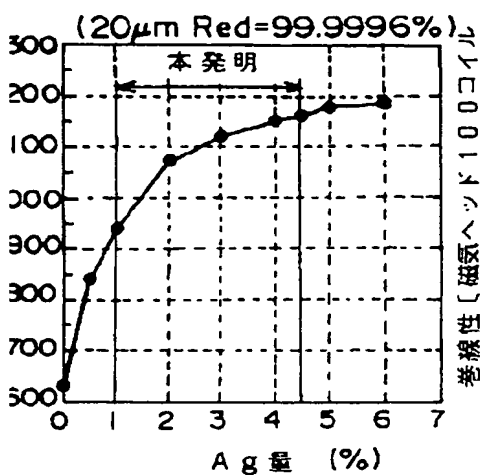


wing 7]



wing 6]

(二)



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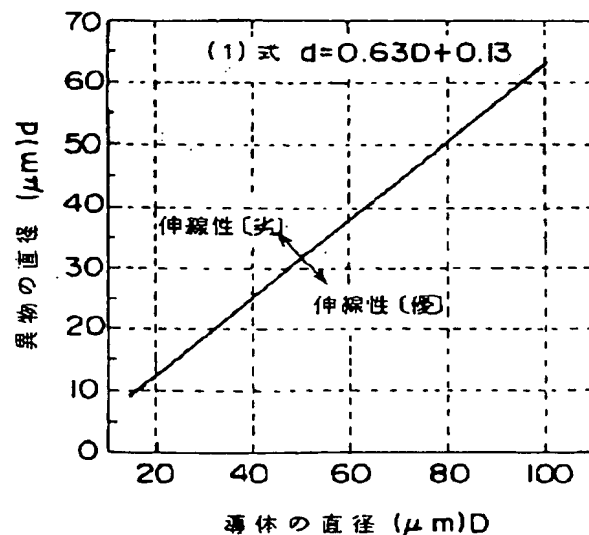
(54)【発明の名称】 巻線用極細導体およびその製造方法

(57)【要約】

【課題】 導電性、引張強度、伸線性、巻線性に優れる巻線用極細導体を提供する。

【解決手段】 Agを1～4.5重量%（以下、%と略記する）含み、残部がCuと不可避不純物からなる極細導体であり、前記極細導体内に含まれる異物の径が $d \mu m$ 以下の巻線用極細導体。但し、 $d = 0.63D + 0.13$ （式中、 $D$ は極細導体の径 $\mu m$ ）

【効果】 銀を適量含む銅合金からなり、また導体に含まれる異物の径を所定値以下（極細導体との断面積比で40%以下）に規定するので伸線性および巻線性に優れる。



## 【特許請求の範囲】

【請求項1】 Agを1～4.5重量%（以下、%と略記する）含み、残部がCuと不可避不純物からなる極細導体であり、前記極細導体内に含まれる異物の径が $d\mu\text{m}$ 以下であることを特徴とする巻線用極細導体。但し、 $d=0.63D+0.13$ （式中、Dは極細導体の径 $\mu\text{m}$ ）

【請求項2】 Agを1～4.5%含み、残部がCuと不可避不純物からなる銅合金鋳塊に冷間加工を施す極細導体の製造方法であって、前記鋳塊は、鋳造組織のデンドライトアームスペースが $15\mu\text{m}$ 以下、Ag晶出物が $15\mu\text{m}$ 以下の径で均一に分散したものであり、前記冷間加工を99.997%以上の加工率で施すことを特徴とする請求項1記載の巻線用極細導体の製造方法。

【請求項3】 Agを1～4.5%含み、残部がCuと不可避不純物からなる銅合金鋳塊に冷間加工を施す極細導体の製造方法であって、前記鋳塊は、鋳造組織のデンドライトアームスペースが $15\mu\text{m}$ 以下、Ag晶出物が $15\mu\text{m}$ 以下の径で均一に分散したものであり、前記冷間加工の途中に再結晶温度未満の温度で焼鈍を施すことを特徴とする請求項1記載の巻線用極細導体の製造方法。

## 【発明の詳細な説明】

## 【0001】

【発明の属する技術分野】本発明は、時計用のステッピングモーター、オーディオ・ビデオの磁気ヘッドまたはボイスコイル、携帯電話やポケベル用の振動モーター、各種超小型リレー、パソコンやテレビのバックライトトランスまたはフライバックトランス、自動車に搭載する電子機器のコイルなどに使用され、導電性、機械的性質、伸線性、巻線性に優れる巻線用極細導体およびその製造方法に関する。

## 【0002】

【従来の技術】巻線用極細導体はエナメル被覆後マグネットコイルなどに整形される。その材料にはタフピッチ銅（TPC）や無酸素銅（OFC）などが用いられているが、これら材料は、低強度のため伸線加工や巻線加工で断線し易い。断線が生じると、連続伸線機を停止し、断線部分を除去し、線材をダイスに通し、ダイスを伸線機にセットするという手間を要し生産性が害される。また断線が生じると単位長さ不足による不良品が増加する。また伸線加工は、昼夜を通して行われ、完全無人体制の夜間に断線すると伸線機は翌朝まで停止して生産性は大幅に低下する。そのため24時間連続伸線可能な伸線性に優れる高品質の導体が要求されている。近年、電子機器の小型化・軽量化に伴って $20\mu\text{m}$ 以下の極細導体が要求されるようになったが、因みに、 $20\mu\text{m}$ 径の導体を $400\text{m}/\text{分}$ の速度で24時間連続伸線するときの伸線量は $1610\text{g}$ であり、安全係数を10%にとると $1800\text{g}/\text{Br}$ の伸線性が必要になる。さらに、径が2

$0\mu\text{m}$ 程度の極細導体は数10グラムの張力で破断するため、自動巻線機では後方張力の微妙な変動によって断線する。手動巻線機では操作に熟練を要した生産性に劣るという問題がある。

【0003】このようなことから、巻線用極細導体として、強度と導電性に優れるCu-Ag系合金導体がクローズアップされ、これまでに下記①～⑥の提案がなされた。しかし、いずれも高価なAgを多量に含むか、高温焼鈍を複数回必要とするためコストおよび生産性の点で問題がある。即ち、①Agを5～15%含む銅合金の線材表面から銅を選択的に酸洗除去して表層のAg濃度を高め、富化Agにより表層の傷の補修と異物の被覆を行い、さらに延性に富むAgの潤滑作用で断線を防止した巻線用極細導体（特開平7-96321号公報）。②Agを15～30%含む銅合金を連続鋳造法で小径の棒状鋳塊とし、熱間鍛造と面削の工程を省略した高磁界発生用マグネット用導体（特開平6-93398号公報、特開平6-93399号公報、特開平6-103809号公報）。③Agを15～30%含む銅合金鋳塊を加工率95%以上で加工し、その後再結晶温度以上の温度で焼鈍し冷間加工して伸びと導電性を回復させた径が $0.1\text{mm}$ 以上の導体（特開平6-93398号公報）。④Agを15～30%含む銅合金鋳塊を再結晶温度以上の温度での焼鈍を入れて冷間加工して導電率を回復させた $0.9\text{mm}$ 径程度の導体（特開平6-93399号公報）。⑤Agを15～30%含む銅合金鋳塊を95%以上の加工率で加工し、その後再結晶温度以上の温度で焼鈍して冷間加工した $0.1\text{mm}$ 径の導体（特開平6-103809号公報）。⑥Agを2～2.8%含む銅合金の金型鋳塊を溶体化処理し、その後伸線加工と時効処理を複数回繰返して強度を向上させてケーブルの補強鉄編組を省略した $0.65\text{mm}$ 径の海底ケーブル用導体（特開昭48-44798号公報）。

## 【0004】

【発明が解決しようとする課題】そこで、本発明者等は、Agを含む銅合金の巻線への適用について鋭意研究を行い、伸線性と巻線性に適したAgの添加量を明らかにし、さらに伸線性と巻線性に優れる鋳造組織、異物サイズの許容限度などについて研究を進めて本発明を完成させるに至った。本発明は、導電性、引張強度、伸線性、巻線性に優れる巻線用極細導体およびその製造方法の提供を目的とする。

## 【0005】

【課題を解決するための手段】請求項1記載の発明は、Agを1～4.5重量%（以下、%と略記する）含み、残部がCuと不可避不純物からなる極細導体であり、前記極細導体内に含まれる異物の径が $d\mu\text{m}$ 以下であることを特徴とする巻線用極細導体である。但し、 $d=0.63D+0.13$ （式中、Dは極細導体の径 $\mu\text{m}$ ）

【0006】請求項2記載の発明は、Agを1～4.5%含み、残部がCuと不可避不純物からなる銅合金鋳塊

に冷間加工を施す極細導体の製造方法であって、前記鋳塊は、鋳造組織のデンドライトアームスペースが $15\mu\text{m}$ 以下、Ag晶出物が $15\mu\text{m}$ 以下の径で均一に分散したものであり、前記冷間加工を99.997%以上の加工率で施すことを特徴とする請求項1記載の巻線用極細導体の製造方法である。

【0007】請求項3記載の発明は、Agを1~4.5%含み、残部がCuと不可避不純物からなる銅合金鋳塊に冷間加工を施す極細導体の製造方法であって、前記鋳塊は、鋳造組織のデンドライトアームスペースが $15\mu\text{m}$ 以下、Ag晶出物が $15\mu\text{m}$ 以下の径で均一に分散したものであり、前記冷間加工の途中に再結晶温度未満の温度で焼鈍を施すことを特徴とする請求項1記載の巻線用極細導体の製造方法である。

【0008】

【発明の実施の形態】本発明は、Agを1~4.5%含み、残部がCuと不可避不純物からなる極細導体内に含まれる異物の径を $d\mu\text{m}$ 以下に規定して伸線性および巻線性を向上させた極細導体である。但し、 $d=0.63D+0.13$ （式中、Dは極細導体の径 $\mu\text{m}$ ）

本発明において、合金元素のAgは短繊維状に分散して、導電性を余り低下させることなく、極細導体の強度を高め、以て伸線性と巻線性を改善する。Agの含有量を1~4.5%に規定する理由は、1%未満では前記伸線性と巻線性が十分に改善されず、4.5%を超えると導電性が低下するうえ、材料コストが高くなるためである。Agの含有量は1.5~4%が特に望ましい。

【0009】前記異物径の規定は次の実験に基づいてなされた。即ち、SCR式連続鋳造機により製造されたCu-2%Ag合金の荒引線（8mm径）を素材として、これを $100\sim 200\mu\text{m}$ 径の導体に伸線加工し、その際断線した導体の破面に残存する異物の大きさを走査電子顕微鏡（SEM）により測定した。そして、異物の径は、 $100\mu\text{m}$ 径の導体で $63\mu\text{m}$ 以上、 $200\mu\text{m}$ 径の導体で $13\mu\text{m}$ 以上であり、径Dの導体における異物の許容径dは、図1に示すように $d=0.63D+0.13$ の(1)式で表されることを明らかにし、この(1)式を基に、例えば、 $200\mu\text{m}$ 径の極細導体を無断線で伸線するには、異物径は $12\mu\text{m}$ 以下にすれば良いことを見いだした。別の実験により、大型鋳塊の押出材を素材とする場合も同じ結果が得られた。また断線と異物径の関係などはタブピッチ銅（TPC）や無酸素銅（OFC）においても同様であることが確認された。前記(1)式の間隔を極細導体の断面積Tと異物の断面積との比 $t/T$ と、伸線性（断線に到るまでの伸線量）との関係で表すと図2に示すようになり、極細導体に占める異物の断面積比（以下、異物占積率と称す）は、断線時の極細導体径Dに関係なく約40%であり、異物占積率が40%を超えると断線が生じ易くなることが判る。

【0010】前記異物をX線マイクロアナライザー（E

PMA）により同定したところ、主に $\text{Al}_2\text{O}_3$ 、 $\text{SnO}_2$ 、 $\text{CuO}$ などの酸化物粒子、炭化物（ $\text{SiC}$ ）粒子、などの非金属介在物であった。前記異物は、主に、銅合金溶湯の溶解から鋳造に至るまでの経路となる溶解炉、保持炉、タンディッシュ、これらを繋ぐ樋などを構成するアルミナ系またはシリカ系耐火材から混入する。本発明において、異物とは、断線に影響する前記非金属介在物を指す。なお、Fe、Cr、Niなどの金属介在物が加工治具などから混入する場合があるが、これらは径が数 $\mu\text{m}$ 程度の小さいものが殆どで断線の原因にはなり難いものである。本発明において、異物の形状は、扁平状、楕円状、球状が殆どであり、これら異物の径は、扁平状異物の場合は最大幅と最大長さの平均値、楕円状異物の場合は短径と長径の平均値、球状の場合は最大径とする。

【0011】大型設備で鋳造した鋳塊（素材）を加工した導体は $100\mu\text{m}$ 径あたりから異物断線が多発するが、小型の横型連続鋳造設備を用い通常のメンテナンスを行って鋳造した鋳塊（素材）は、 $30\mu\text{m}$ 径まで無断線で加工できる。しかし径が $20\mu\text{m}$ 前後の極細導体を無断線で伸線するには、異物は $12\mu\text{m}$ 径以下、望ましくは $10\mu\text{m}$ 径以下にする必要があり、そのためには、通常のメンテナンスだけでなく、例えば、溶湯を長時間鎮静して重い異物は炉底に沈降させ、軽い異物は湯面に浮上させ、中間部分の異物の少ない溶湯を鋳造するなどの特殊な溶湯処理が必要になる。このようにすれば $17\mu\text{m}$ 径程度まで伸線加工が可能になる。請求項2、3記載の発明は、熱間加工或いは高温焼鈍を行わないので、酸化スケールが異物として混入する機会が少ない。

【0012】請求項2記載の発明は、鋳造組織のデンドライトアームスペース（DAS）が $15\mu\text{m}$ 以下、Ag晶出物が $15\mu\text{m}$ 以下の径で均一に分散した鋳塊を用い、加工率99.997%以上で冷間加工する巻線用極細導体の製造方法である。前記鋳塊を、DASが $15\mu\text{m}$ 以下、Ag晶出物が $15\mu\text{m}$ 以下の径で均一に分散する鋳造組織に規定する理由は、鋳塊の冷間加工性が向上し、また導体表面の凹凸欠陥が減少して絶縁被覆性が向上するためである。冷間加工の加工率を99.997%以上に規定する理由は、鋳塊中に分散するAg晶出物が短繊維状に微細に分散されるなど鋳造組織が十分に破壊されて極細導体のしなやかさが増しコイルリング性が向上するためである。

【0013】DASは溶湯凝固時の冷却速度に依存し、冷却速度の大きい小型鋳塊ほど小さくなる。即ち、図3に示すようにDASは縦型連続鋳造鋳塊（ $200\text{mm}\phi$ ）、SCR鋳塊（ $100\times 50\text{mm}$ ）、小型横型連続鋳造機鋳塊A（ $10\text{mm}\phi$ ）の順に小さくなる。鋳塊の大きさが同じ場合は、DASは鋳型の温度勾配に依存する。即ち、小型横型連続鋳造機の鋳塊の場合、鋳型の温度勾配を $50^\circ\text{C}/\text{cm}$ に設定した鋳塊AのDASは18

$\mu\text{m}$ 以上と大きく、鋳型の温度勾配を  $100^\circ\text{C}/\text{cm}$  に設定した鋳塊 B の D A S は  $15\mu\text{m}$  以下に小さくなっている。つまり、D A S が  $15\mu\text{m}$  以下、A g 品出物か  $15\mu\text{m}$  以下の径で均一に分散した鋳造組織の鋳塊は、小型の鋳型を用い鋳型の温度勾配を大きくして鋳造することにより得ることができる。

【0014】請求項 3 記載の発明は、請求項 2 記載の発明における冷間加工の途中に再結晶温度未満の温度で焼鈍を入れてトータルの加工率を向上させた巻線用極細導体の製造方法である。以下に前記焼鈍による効果を図 4 を参照して具体的に説明する。図 4 において、曲線 a は、A g を 3% 含む  $15\text{mm}$  径の銅合金棒状鋳塊の加工硬化特性である。曲線 a は、加工歪み  $\epsilon$  が 12 で最大強度を示し、その後加工軟化するとともに延性が低下して伸線加工ができなくなる。 $\epsilon$  が 13 (線径  $22\mu\text{m}$ 、加工率 99.99978%) で加工限界となる。

【0015】曲線 b は、曲線 a の材料を  $\epsilon$  が 8.71 のイ点で比較的低温で焼鈍したときの加工硬化特性である。曲線 b の最大強度は曲線 a の最大強度と同程度で、そのときの  $\epsilon$  ( $\epsilon_1$ ) は 15 (線径  $5\mu\text{m}$ 、加工率 99.99988%) に増加している。前記焼鈍は、内部を  $700^\circ\text{C}$  の不活性ガス雰囲気とした長さ  $2\text{m}$  の走間焼鈍炉内を  $200\text{m}/\text{分}$  の速度で通過させて行った。焼鈍後の引張強度は  $985\text{N}/\text{mm}^2$  であり、この強度は曲線 a の  $\epsilon$  ( $\epsilon_1$ ) が 6 に相当する強度であり、歪み除去率は  $31\% = [(\epsilon_1 - \epsilon_2) / \epsilon_1 \times 100]$  である。前記強度  $985\text{N}/\text{mm}^2$  を、図 5 の静的焼鈍軟化特性に当てはめると、前記走間焼鈍は  $300^\circ\text{C} \times 1$  時間の静的焼鈍に相当し、再結晶温度未満である。なお、前記図 5 は、曲線 a の材料の加工歪み  $\epsilon$  が 8.71 のイ点 (線径  $193\mu\text{m}$ 、加工率 99.98%、引張強度  $1070\text{N}/\text{mm}^2$ ) の静的焼鈍軟化特性である。このように、冷間加工の途中に再結晶温度未満の温度で焼鈍を入れることにより、高強度を維持してトータル加工率を高めることができる。従って、より極細の導体を得られ、または素材 (鋳塊) 径を大きくできて生産性が向上する。焼鈍を入れる導体サイズ

(径) は、焼鈍後の目標径までの伸線加工で導体強度が加工限界前の最高強度になるように選定するのが望ましい。前記焼鈍は再結晶温度未満の低温で行うのでエネルギー的に有利である。前記焼鈍は複数回繰り返して行っても良い。またインラインで行う方が、アウトラインで行うより生産性に優れる。バッチ焼鈍でも同様の効果が得られる。

【0016】曲線 c は、曲線 a の材料を  $\epsilon$  ( $\epsilon_1$ ) が 8.71 のイ点で比較的高温 (再結晶温度以上の温度) で焼鈍したときの加工硬化特性である。曲線 c の材料は  $\epsilon$  が 16.5 (線径  $4\mu\text{m}$ 、加工率 99.99993%) で断線しており、その破断強度は曲線 a、b の材料よりかなり低い。この曲線 c の材料は強度が低いため自動巻線機で断線し易くコイルリング性が悪い。この曲線 c の材料は、

種々の伸線機を用いて何回か伸線加工したが、いずれも  $4\mu\text{m}$  前後で断線した。つまり  $4\mu\text{m}$  が伸線加工限界である。伸線加工限界の導体は素材が何であれ使用を避けるべきである。曲線 c の材料の焼鈍は、内部を  $1000^\circ\text{C}$  の不活性ガス雰囲気とした長さ  $2\text{m}$  の走間焼鈍炉内を  $150\text{m}/\text{分}$  の速度で通過させて行った。焼鈍後の引張強度は  $420\text{N}/\text{mm}^2$  であり、この強度は曲線 a の  $\epsilon$  ( $\epsilon_1$ ) が 0.1 に相当する強度で、歪み除去率は  $99\% = [(\epsilon_1 - \epsilon_2) / \epsilon_1 \times 100]$  である。前記引張強度  $420\text{N}/\text{mm}^2$  を図 5 に当てはめると、前記走間焼鈍は  $500^\circ\text{C} \times 1$  時間の静的焼鈍に相当する。ミクロ組織観察で再結晶が終了していることが確認された。

【0017】

【実施例】以下に本発明を実施例により詳細に説明する。

(実施例 1) 電気銅に本発明規定内で A g を種々の量配合し、これを黒鉛するつぼで溶製し、金型にて  $10\text{mm}$  径の鋳塊に鋳造し、この鋳塊を  $20\mu\text{m}$  径の極細導体に伸線加工 (加工率 99.9996%) した。得られた各種細導体について、引張強度 (T S)、導電率 (E C)、伸線性、巻線性、および伸線性と巻線性の関係を調べた。比較のため本発明規定外組成の Cu-A g 合金および無酸素銅についても同様にして極細導体を製造し同じ調査を行った。結果を図 6 (イ) ~ (ホ) に示す。図 6 (イ) に引張強度と A g 含有量との関係を示した。A g を 1 ~ 4.5% 含有する本発明例品は  $940 \sim 1150\text{N}/\text{mm}^2$  の高強度であることが判る。A g が 1% 未満で引張強度は急激に低下する。図 6 (ロ) に導電率と A g 含有量との関係を示した。A g を 1 ~ 4.5% 含む本発明例品は  $88.5 \sim 81.5\%$  I A C S の高い導電率を有することが判る。A g が 4.5% を超えると導電率は規格値 ( $81.5\%$ ) 未満に低下する。図 6 (ハ) に  $25\mu\text{m}$  から  $20\mu\text{m}$  に伸線するときの伸線性 (1 断線あたりの伸線量) と A g 含有量との関係を示した。A g を 1 ~ 4.5% 含む本発明例品は  $1800 \sim 2500\text{g}/\text{Br}$  の高い伸線性を有することが判る。A g が 1% 未満では  $20\mu\text{m}$  径の極細導体の 24 時間連続伸線に必要な  $1800\text{g}/\text{Br}$  の伸線性が保証されない。A g が 1 ~ 3% での伸線性の向上は合金化による効果であり、4.5% を超えての伸線性の急激な低下は共晶組織の出現によるものである。図 6 (ニ) に巻線性と A g 含有量との関係を示した。巻線性はエナメル被覆した  $20\mu\text{m}$  径の極細導体を手動巻線機または自動巻線機でコイルリングして磁気ヘッドを  $100$  個作製したときの断線回数で表した。A g を 1 ~ 4.5% 含む本発明例品の断線回数は、自動巻線機で 4 回以下、手動巻線機で 1 回以下でいずれも少ない。巻線性から見た特に望ましい A g 含有量は 1.5 ~ 4% である。図 6 (ホ) に伸線性 (1 断線あたりの伸線量) と巻線性 (100 コイル作製中の断線回数) との関係を示した。伸線性に優れる導体は巻線性にも優れている。図 6

(イ)～(ホ)から、Cu-1～4.5%Ag合金からなる本発明の極細導体は、80%IACS以上の高導電性で、950～1150N/mm<sup>2</sup>の高強度を有し、しかも伸線性と巻線性に優れることが判る。

【0018】(実施例2)下記4種の素材(Cu-2%Ag合金)を伸線加工して25μm径の極細導体とし、これを20μm径まで400m/分(67g/hr)の速度で連続伸線して、断線に到るまでのトータル伸線時間を調べた。また破面に残存した異物または酸溶解法にて採取した異物の径をSEM観察により測定した。両者の関係を図7に示す。トータル伸線時間は、各3ボビンずつ連続伸線し、1回目の断線が起きるまでの連続伸線時間をボビンごとに測定し、その合計をトータル伸線時間とした。例えば、第1ボビンが5時間後に断線し、第2ボビンが3時間後に断線し、第3ボビンが4時間後に断線した場合のトータル伸線時間は12時間とした。1ボビン(最大巻量2500g)の伸線時間は37時間なので最大のトータル伸線時間は111時間である。また前記酸溶解法は極細導体を1ボビンあたり5か所から各100gずつサンプリングし、これを酸に溶かし濾過して採取する方法である。素材は次の4種である。①SCR方式で製造した8mmφの荒引線、②縦型連続・押出方式で製造した10mmφの押出材、③通常メンテナンスの小型横型連続鑄造装置を用いて鑄造した10mmφの鑄塊、④特殊な溶湯処理で異物を十分除去した溶湯を小型横型連続鑄造装置を用いて鑄造した10mmφの鑄塊(本発明例)。図7より、トータル伸線時間は、異物が小さいほど長くなり、異物径が10μm以下の④材が最も長く、異物径が10μmを超える①～③材は伸線性が大幅に短くなっている。前記実施例ではCu-2%Ag合金について説

明したが、本発明はCu-1～4.5%Ag合金に適用して同様の効果が得られる。

【0019】前記④のボビン(20μm径、最大巻量2500g)に巻取った極細導体(Cu-2%Ag合金)を自動巻線機によりコイリングしたか、断線は全く起きなかった。

【0020】前記④のボビン(20μm径、最大巻量2500g)に巻取った極細導体をさらに17μm径に連続伸線し、巻取ったボビンから前述と同じように酸溶解法により異物を採取し、異物径をSEM観察により測定した。異物径はいずれも10μm以下であった。

【0021】(実施例3)Agを2%または4%含む銅合金を溶製し、異物を沈降または浮上させ、中間部分の溶湯を小型横型連続鑄造装置により10mm径の鑄塊に連続鑄造し、これを50～15μmの極細導体に伸線加工した。前記連続鑄造での鑄型の温度勾配は100℃/cmにした。前記鑄塊の鑄造組織は微細で、DASおよびAg晶出物は15μm以下であり、Ag晶出物は均一に分散していた。比較のため、鑄型の温度勾配を50℃/cm以下にして連続鑄造した鑄塊についても同様に50～15μmの極細導体に伸線加工した。この鑄塊は鑄造組織が比較的粗く、DAS、Ag晶出物とも18μm以上で、Ag晶出物は不均一に分散していた。得られた各々の極細導体について、伸線性(g/Br)、引張強度(TS)、導電率(EC)を調べた。結果を表1に示す。なお、伸線性は190→50μm、50→32μm、32→25μm、25→20μm、20→15μmにそれぞれ連続伸線したときの値である。

【0022】

【表1】

| 導体<br>径<br>μm | 鑄塊から<br>の冷間<br>加工率% | x Cu-2%Ag<br>15≧DAS, Ag晶出物 |            | y Cu-4%Ag<br>15≧DAS, Ag晶出物 |            | z Cu-2%Ag<br>18≧DAS,<br>Ag晶出物<br>伸線性 |
|---------------|---------------------|----------------------------|------------|----------------------------|------------|--------------------------------------|
|               |                     | 伸線性                        | TS/EC      | 伸線性                        | TS/EC      |                                      |
| 50            | 99.99750            | >5000                      | 1045/85.10 | >5000                      | 1095/82.35 | 4706                                 |
| 32            | 99.99897            | >5000                      | 1075/85.06 | >5000                      | 1125/82.27 | 4451                                 |
| 25            | 99.99937            | 3510                       | 1090/85.00 | 3360                       | 1140/82.15 | 1890                                 |
| 20            | 99.99960            | 2450                       | 1095/84.96 | 2347                       | 1150/82.11 | 730                                  |
| 15            | 99.99977            | 2275                       | 1105/84.85 | 2153                       | 1155/81.95 | 410                                  |

(注) 伸線性g/Br、TS(引張強度)N/mm<sup>2</sup>、EC(導電率)%IACS。

【0023】表1より明らかなように、鑄造組織が微細な鑄塊から得られた極細導体x、yは、前記鑄造組織が比較的粗い鑄塊から得られた極細導体zより伸線加工性

が優れた。なお、zの伸線加工性が25μm以下で悪い主な原因は鑄造条件が不適当なことで、線材の外部品質が悪かったためである。以上Agを2%または4%含む



銅合金について説明したか、Cu-1~4.5%Ag合金においても同様の効果が得られる。

【0024】(実施例4) 実施例3で製造した20 $\mu$ m径のCu-2%Ag合金導体x、zにエナメルを被覆してその絶縁特性を高圧均一性試験により評価した。高圧均一性試験は、走行するエナメル線と電極輪間に電圧を印加し、スパークの発生によりエナメル線の絶縁不良を

検知する試験である。試験条件はエナメル線の走行速度5m/分、印加電圧500Vとした。試験本数は長さ30mのエナメル線を30本とした。絶縁特性は1本当たりの平均スパーク発生数で表した。結果を表2に示す。

【0025】

【表2】

| エナメル厚さ | 6 $\mu$ m | 5 $\mu$ m | 4 $\mu$ m | 3 $\mu$ m | 2 $\mu$ m | ※鋳塊の鋳造組織 |
|--------|-----------|-----------|-----------|-----------|-----------|----------|
| 表1のx   | 0         | 0         | 0         | 0         | 0.1       | 微細       |
| 表1のz   | 0         | 0.03      | 0.1       | 0.7       | 1.4       | 比較的粗い    |

(注) ※DASとAg晶出物は15 $\mu$ m以下、Ag晶出物は均一分散。

DASとAg晶出物は18 $\mu$ m以上、Ag晶出物は不均一分散。

【0026】極細導体xは3 $\mu$ mのエナメル皮膜厚さで十分な絶縁効果が得られた。これは用いた鋳塊が微細な鋳造組織のため導体表面の凹凸欠陥が減少したためである。極細導体zは用いた鋳塊が比較的粗い鋳造組織のため十分な絶縁効果を得るのに6 $\mu$ m以上のエナメル皮膜厚さが必要であった。

【0027】前記極細導体x、zのエナメル被覆線を自動巻線機にてフロッピーディスク用磁気ヘッドに各々100個づつコイルリングし、そのときの断線回数を調べた。結果を表3に示す。

【0028】

【表3】

| エナメル厚さ | 6 $\mu$ m | 5 $\mu$ m | 4 $\mu$ m | 3 $\mu$ m | 2 $\mu$ m | ※鋳塊の鋳造組織 |
|--------|-----------|-----------|-----------|-----------|-----------|----------|
| 表1のx   | 0         | 0         | 0         | 0         | 0         | 微細       |
| 表1のz   | 0         | 0         | 1         | 2         | 2         | 比較的粗い    |

(注) ※DASとAg晶出物は15 $\mu$ m以下、Ag晶出物は均一分散。

DASとAg晶出物は18 $\mu$ m以上、Ag晶出物は不均一分散。

【0029】表3より明らかなように、極細導体xは無断線であったが、極細導体zは一部に断線が発生した。これはDASとAg晶出物が大きくまたAg晶出物の分散が不均一で極細導体のしなやかさが不足したためである。

【0030】(実施例5) 図4に示したAgを3%含む15mm径の銅合金棒状鋳塊の加工硬化曲線bと加工硬

化曲線c(比較例)の極細導体(37~8.3 $\mu$ m)の引張強度(TS)を調べた。また各々の極細導体に3 $\mu$ m厚さにエナメルを被覆し、このエナメル被覆線を自動巻線機でコイルリングしたときの断線回数を調べた。結果を表4に示す。

【0031】

【表4】

| 導体径 $\mu m$             |      | 37        | 22        | 14        | 8.3       |
|-------------------------|------|-----------|-----------|-----------|-----------|
| 全加工歪 $\varepsilon$      |      | 12.0      | 13.0      | 14.0      | 15.0      |
| 全減面率 %                  |      | 99.999391 | 99.999784 | 99.999912 | 99.999969 |
| TS<br>N/mm <sup>2</sup> | 曲線 b | 1080      | 1115      | 1140      | 1150      |
|                         | 曲線 c | 875       | 930       | 984       | 1010      |
| コiling<br>時の断<br>線回数    | 曲線 b | 0         | 0         | 0         | 0         |
|                         | 曲線 c | 1         | 2         | 2         | 3         |

【0032】表4より明らかなように、本発明例の極細導体（曲線b）は、比較例の極細導体（曲線c）より引張強度が、いずれの導体径においても高かった。比較例の極細導体は引張強度が低いため自動巻線機でのコiling時に断線が生じた。以上Agを3%含む銅合金について説明したが、それ以外のCu-1~4.5%Ag合金に適用しても同様の効果が得られる。

【0033】

【発明の効果】以上に述べたように、本発明の巻線用極細導体は、銀を適量含む高強度の銅合金からなり、しかもそこに含まれる異物の径を規定するので伸線性および巻線性に優れる。本発明の巻線用極細導体は、鑄造組織のDASとAgの晶出物径などを規定した鑄塊を99.997%以上の加工率で冷間加工することにより容易に製造できる。前記冷間加工の途中で再結晶温度未満の温度で焼鈍を入れることによりトータル加工率を大きくすることができ、導体の極細化または素材の大型化が図れ

る。

【図面の簡単な説明】

【図1】伸線性に関する異物径と導体径の関係を示す図である。

【図2】伸線性と異物占積率との関係を示す図である。

【図3】DASと鑄塊径の関係を示す図である。

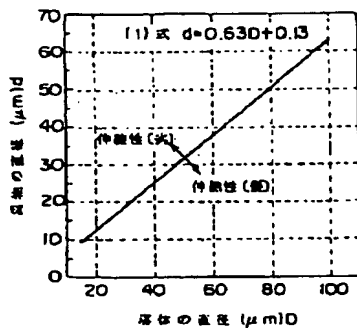
【図4】引張強度と加工歪みの関係（加工硬化特性）を示す図である。

【図5】引張強度と焼鈍温度の関係（焼鈍軟化特性）を示す図である。

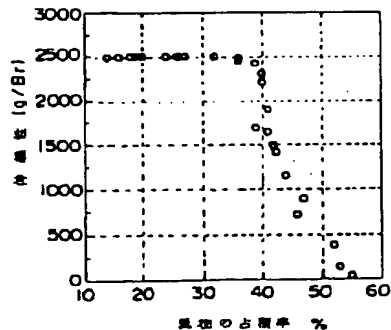
【図6】本発明の巻線用極細導体におけるAg含有量と引張強度（i）、導電率（o）、伸線性（h）、巻線性（n）との関係、および伸線性と巻線性の関係（h）を示すそれぞれ説明図である。

【図7】20 $\mu m$ 径の極細導体における伸線性と異物径との関係を示す図である。

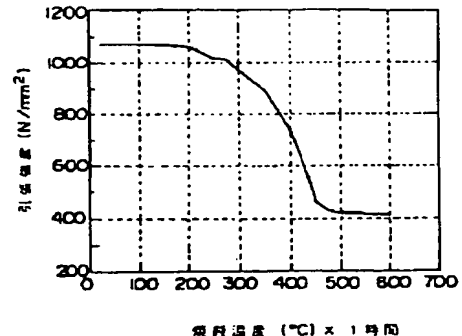
【図1】



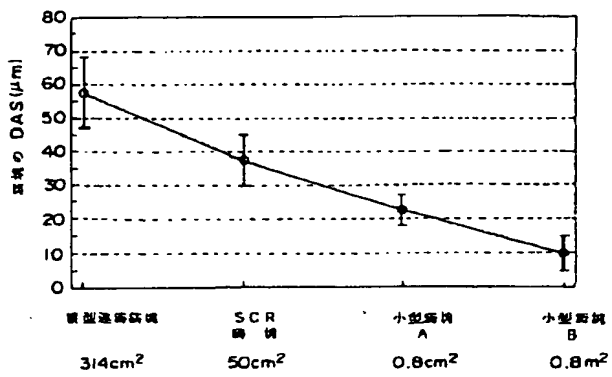
【図2】



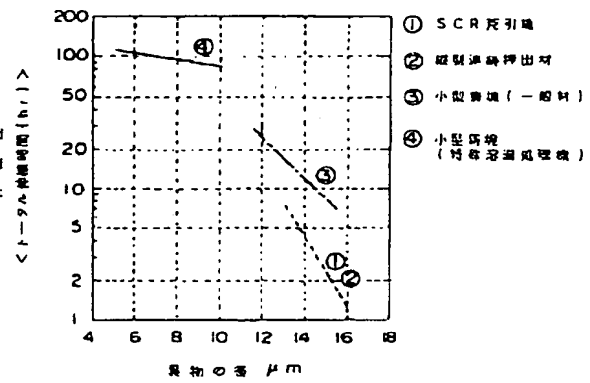
【図5】



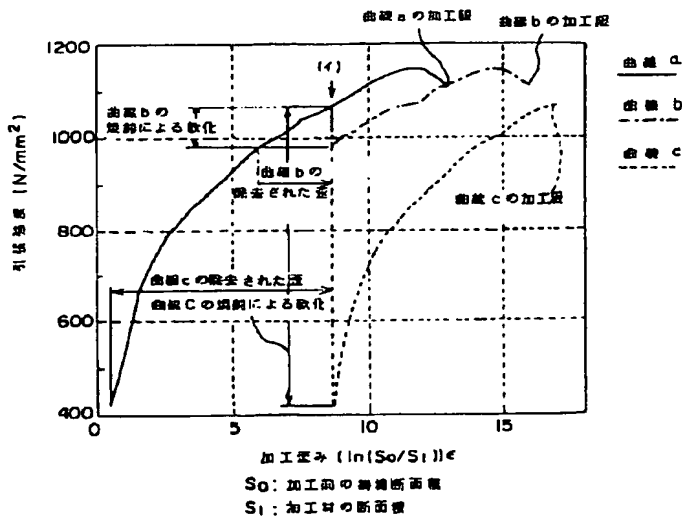
【図3】



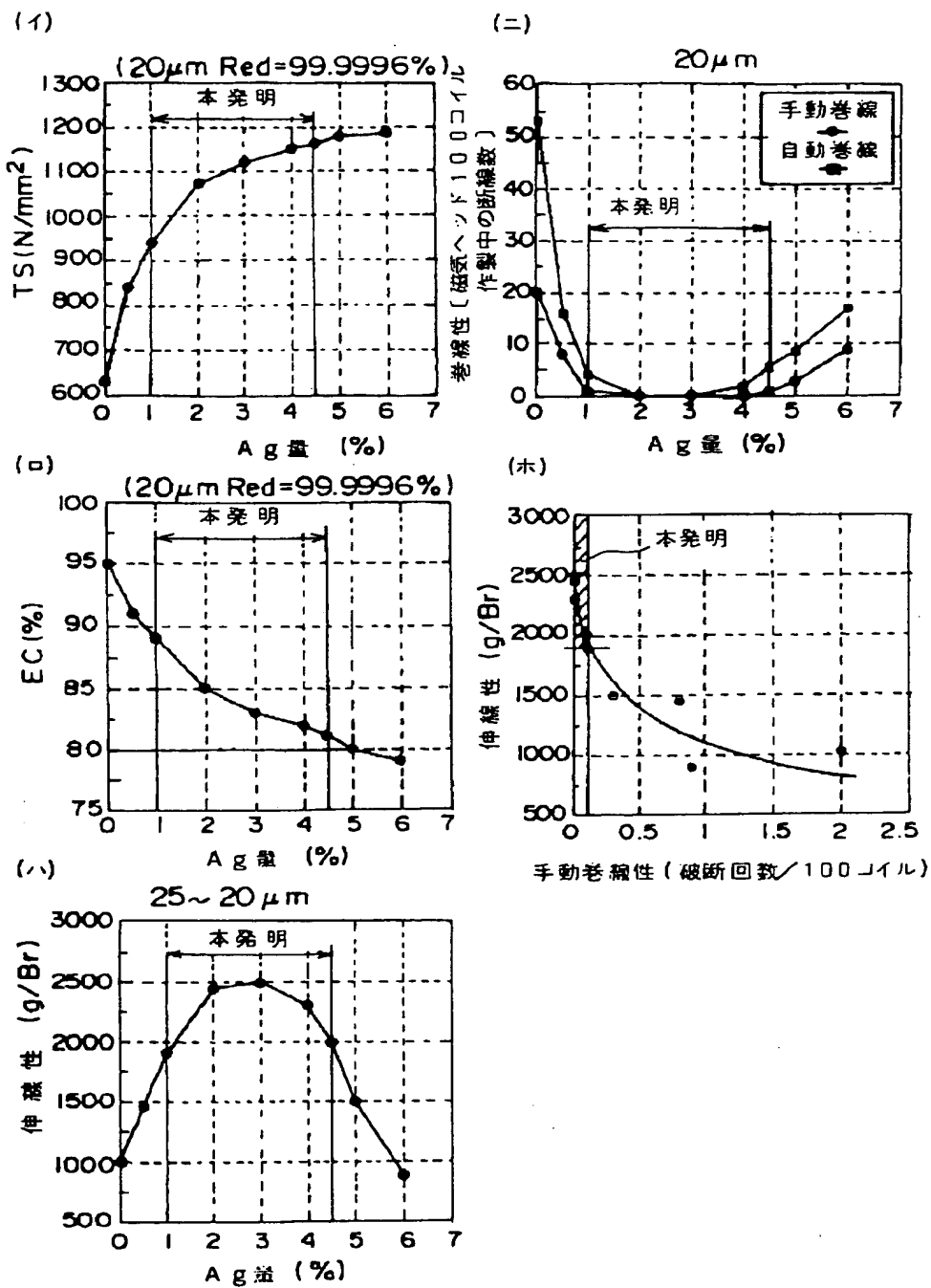
【図7】



【図4】



【図6】



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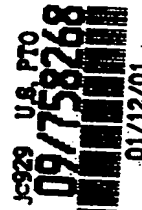
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SUPER-FINE CONDUCTOR FOR WINDING, AND ITS MANUFACTURE  
FURUKAWA ELECTRIC CO LTD:THE

Inventor(s): YAMAZAKI AKIRA ;FUJIWARA HIDEMICHI ;ANDO MASAYUKI

Application No. 10096512 , Filed 19980409 , Published 19991026

## Abstract:

**PROBLEM TO BE SOLVED:** To provide a conductor excellent in electric conductivity, tensile strength, drawability and coilability by containing foreign matters of specified diameters in a super-fine conductor containing Ag of a specified ratio, and the balance Cu with inevitable impurities.

**SOLUTION:** Ag of 1-4.5 wt.% is contained, and the diameter  $d$  ( $\mu\text{m}$ ) of foreign matters is expressed by the formula  $d=0.63D+0.13$ , where  $D$  is the diameter ( $\mu\text{m}$ ) of a super-fine conductor. In a manufacturing method of the super-fine conductor in which a copper alloy cast ingot preferably containing 1-4.5% Ag and the balance Cu with inevitable impurities is cold rolled, the cast ingot is cold rolled with the working ratio of 99.997% so that the dendrite arm space of the casting structure is 15  $\mu\text{m}$ , and Ag crystal is uniformly dispersed with the diameter of 15  $\mu\text{m}$ , or annealed at the temperature below the re-crystallization temperature during the cold rolling. The total working ratio can be increased to provide a super-fine conductor and to increase the size of a stock material.

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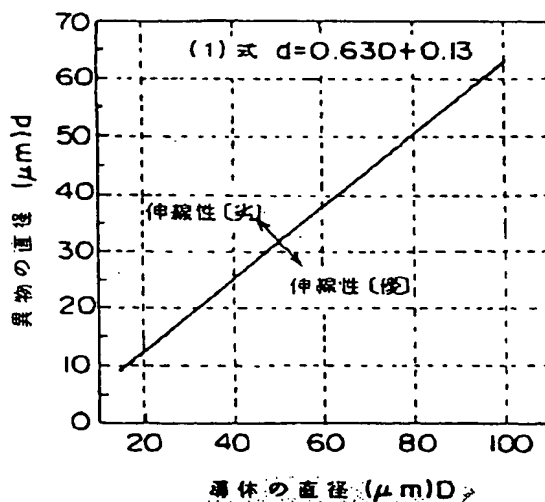
(54) 【発明の名称】 巻線用極細導体およびその製造方法

(57) 【要約】

【課題】 導電性、引張強度、伸線性、巻線性に優れる巻線用極細導体を提供する。

【解決手段】 Agを1～4.5重量%（以下、%と略記する）含み、残部がCuと不可避不純物からなる極細導体であり、前記極細導体内に含まれる異物の径が $d \mu\text{m}$ 以下の巻線用極細導体。但し、 $d = 0.63D + 0.13$ （式中、Dは極細導体の径 $\mu\text{m}$ ）

【効果】 銀を適量含む銅合金からなり、また導体に含まれる異物の径を所定値以下（極細導体との断面積比で40%以下）に規定するので伸線性および巻線性に優れる。



## 【特許請求の範囲】

【請求項1】 Agを1～4.5重量%（以下、%と略記する）含み、残部がCuと不可避不純物からなる極細導体であり、前記極細導体内に含まれる異物の径が $d\mu\text{m}$ 以下であることを特徴とする巻線用極細導体。但し、 $d=0.63D+0.13$ （式中、Dは極細導体の径 $\mu\text{m}$ ）

【請求項2】 Agを1～4.5%含み、残部がCuと不可避不純物からなる銅合金鋳塊に冷間加工を施す極細導体の製造方法であって、前記鋳塊は、鋳造組織のデンドライトアームスペースが $15\mu\text{m}$ 以下、Ag晶出物が $15\mu\text{m}$ 以下の径で均一に分散したものであり、前記冷間加工を99.997%以上の加工率で施すことを特徴とする請求項1記載の巻線用極細導体の製造方法。

【請求項3】 Agを1～4.5%含み、残部がCuと不可避不純物からなる銅合金鋳塊に冷間加工を施す極細導体の製造方法であって、前記鋳塊は、鋳造組織のデンドライトアームスペースが $15\mu\text{m}$ 以下、Ag晶出物が $15\mu\text{m}$ 以下の径で均一に分散したものであり、前記冷間加工の途中に再結晶温度未満の温度で焼鈍を施すことを特徴とする請求項1記載の巻線用極細導体の製造方法。

## 【発明の詳細な説明】

## 【0001】

【発明の属する技術分野】本発明は、時計用のステッピングモーター、オーディオ・ビデオの磁気ヘッドまたはボイスコイル、携帯電話やポケベル用の振動モーター、各種超小型リレー、パソコンやテレビのバックライトトランスまたはフライバックトランス、自動車に搭載する電子機器のコイルなどに使用され、導電性、機械的性質、伸線性、巻線性に優れた巻線用極細導体およびその製造方法に関する。

## 【0002】

【従来の技術】巻線用極細導体はエナメル被覆後マグネットコイルなどに整形される。その材料にはタフピッチ銅（TPC）や無酸素銅（OFC）などが用いられているが、これら材料は、低強度のため伸線加工や巻線加工で断線し易い。断線が生じると、連続伸線機を停止し、断線部分を除去し、線材をダイスに通し、ダイスを伸線機にセットするという手間を要し生産性が害される。また断線が生じると単位長さ不足による不良品が増加する。また伸線加工は、昼夜を通して行われ、完全無人体制の夜間に断線すると伸線機は翌朝まで停止して生産性は大幅に低下する。そのため24時間連続伸線可能な伸線性に優れた高品質の導体が要求されている。近年、電子機器の小型化・軽量化に伴って $20\mu\text{m}$ 以下の極細導体が要求されるようになったが、因みに、 $20\mu\text{m}$ 径の導体を $400\text{m/分}$ の速度で24時間連続伸線するときの伸線量は $1610\text{g}$ であり、安全係数を10%にとると $1800\text{g/Br}$ の伸線性が必要になる。さらに、径が2

$0\mu\text{m}$ 程度の極細導体は $10\text{クラム}$ の張力で破断するため、自動巻線機では後方張力の微妙な変動によって断線する。手動巻線機では操作に熟練を要した生産性に劣るという問題がある。

【0003】このようなことから、巻線用極細導体として、強度と導電性に優れたCu-Ag系合金導体がクローズアップされ、これまでに下記①～⑥の提案がなされた。しかし、いずれも高価なAgを多量に含むか、高温焼鈍を複数回必要とするためコストおよび生産性の点で問題がある。即ち、①Agを5～15%含む銅合金の線材表面から銅を選択的に酸洗除去して表層のAg濃度を高め、富化Agにより表層の腐の補修と異物の被覆を行い、さらに延性に富むAgの潤滑作用で断線を防止した巻線用極細導体（特開平7-96321号公報）。②Agを15～30%含む銅合金を連続鋳造法で小径の棒状鋳塊とし、熱間鍛造と面削の工程を省略した高磁界発生用マグネット用導体（特開平6-93398号公報、特開平6-93399号公報、特開平6-103809号公報）。③Agを15～30%含む銅合金鋳塊を加工率95%以上で加工し、その後再結晶温度以上の温度で焼鈍し冷間加工して伸びと導電性を回復させた径が $0.1\text{mm}$ 以上の導体（特開平6-93398号公報）。④Agを15～30%含む銅合金鋳塊を再結晶温度以上の温度での焼鈍を入れて冷間加工して導電率を回復させた $0.9\text{mm}$ 径程度の導体（特開平6-93399号公報）。⑤Agを15～30%含む銅合金鋳塊を95%以上の加工率で加工し、その後再結晶温度以上の温度で焼鈍して冷間加工した $0.1\text{mm}$ 径の導体（特開平6-103809号公報）。⑥Agを2～2.8%含む銅合金の金型鋳塊を溶体化処理し、その後伸線加工と時効処理を複数回繰返して強度を向上させてケーブルの補強鉄編組を省略した $0.65\text{mm}$ 径の海底ケーブル用導体（特開昭48-44798号公報）。

## 【0004】

【発明が解決しようとする課題】そこで、本発明者等は、Agを含む銅合金の巻線への適用について鋭意研究を行い、伸線性と巻線性に適したAgの添加量を明らかにし、さらに伸線性と巻線性に優れた鋳造組織、異物サイズの許容限度などについて研究を進めて本発明を完成させるに至った。本発明は、導電性、引張強度、伸線性、巻線性に優れた巻線用極細導体およびその製造方法の提供を目的とする。

## 【0005】

【課題を解決するための手段】請求項1記載の発明は、Agを1～4.5重量%（以下、%と略記する）含み、残部がCuと不可避不純物からなる極細導体であり、前記極細導体内に含まれる異物の径が $d\mu\text{m}$ 以下であることを特徴とする巻線用極細導体である。但し、 $d=0.63D+0.13$ （式中、Dは極細導体の径 $\mu\text{m}$ ）

【0006】請求項2記載の発明は、Agを1～4.5%含み、残部がCuと不可避不純物からなる銅合金鋳塊



に冷間加工を施す極細導体の製造方法であって、前記鋳塊は、鑄造組織のデンドライトアームスペースが $15\mu\text{m}$ 以下、Ag晶出物が $15\mu\text{m}$ 以下の径で均一に分散したものであり、前記冷間加工を99.997%以上の加工率で施すことを特徴とする請求項1記載の巻線用極細導体の製造方法である。

【0007】請求項3記載の発明は、Agを1~4.5%含み、残部がCuと不可避不純物からなる銅合金鋳塊に冷間加工を施す極細導体の製造方法であって、前記鋳塊は、鑄造組織のデンドライトアームスペースが $15\mu\text{m}$ 以下、Ag晶出物が $15\mu\text{m}$ 以下の径で均一に分散したものであり、前記冷間加工の途中で再結晶温度未満の温度で焼鈍を施すことを特徴とする請求項1記載の巻線用極細導体の製造方法である。

【0008】

【発明の実施の形態】本発明は、Agを1~4.5%含み、残部がCuと不可避不純物からなる極細導体内に含まれる異物の径を $d\mu\text{m}$ 以下に規定して伸線性および巻線性を向上させた極細導体である。但し、 $d=0.63D+0.13$ （式中、Dは極細導体の径 $\mu\text{m}$ ）

本発明において、合金元素のAgは短繊維状に分散して、導電性を余り低下させることなく、極細導体の強度を高め、以て伸線性と巻線性を改善する。Agの含有量を1~4.5%に規定する理由は、1%未満では前記伸線性と巻線性が十分に改善されず、4.5%を超えると導電性が低下するうえ、材料コストが高くなるためである。Agの含有量は1.5~4%が特に望ましい。

【0009】前記異物径の規定は次の実験に基づいてなされた。即ち、SCR式連続鑄造機により製造されたCu-2%Ag合金の荒引線（8mm径）を素材として、これを $100\sim 200\mu\text{m}$ 径の導体に伸線加工し、その際断線した導体の破面に残存する異物の大きさを走査電子顕微鏡（SEM）により測定した。そして、異物の径は、 $100\mu\text{m}$ 径の導体で $63\mu\text{m}$ 以上、 $20\mu\text{m}$ 径の導体で $13\mu\text{m}$ 以上であり、径Dの導体における異物の許容径dは、図1に示すように $d=0.63D+0.13$ の（1）式で表されることを明らかにし、この（1）式を基に、例えば、 $20\mu\text{m}$ 径の極細導体を無断線で伸線するには、異物径は $12\mu\text{m}$ 以下にすれば良いことを見いだした。別の実験により、大型鋳塊の押出材を素材とする場合も同じ結果が得られた。また断線と異物径の関係などはタブピッチ銅（TPC）や無酸素銅（OFC）においても同様であることが確認された。前記（1）式の間隔を極細導体の断面積Tと異物の断面積tとの比 $t/T$ と、伸線性（断線に到るまでの伸線量）との関係で表すと図2に示すようになり、極細導体に占める異物の断面積比（以下、異物占積率と称す）は、断線時の極細導体径Dに関係なく約40%であり、異物占積率が40%を超えると断線が生じ易くなることが判る。

【0010】前記異物をX線マイクロアナライザー（E

PMA）により同定したところ、主に $\text{Al}_2\text{O}_3$ 、 $\text{SnO}_2$ 、 $\text{CuO}$ などの酸化物粒子、炭化物（SiC）粒子、などの非金属介在物であった。前記異物は、主に、銅合金溶湯の溶解から鑄造に至るまでの経路となる溶解炉、保持炉、タンディッシュ、これらを繋ぐ樋などを構成するアルミナ系またはシリカ系耐火材から混入する。本発明において、異物とは、断線に影響する前記非金属介在物を指す。なお、Fe、Cr、Niなどの金属介在物が加工治具などから混入する場合があるが、これらは径が数 $\mu\text{m}$ 程度の小さいものが殆どで断線の原因にはなり難いものである。本発明において、異物の形状は、扁平状、楕円状、球状が殆どであり、これら異物の径は、扁平状異物の場合は最大幅と最大長さの平均値、楕円状異物の場合は短径と長径の平均値、球状の場合は最大径とする。

【0011】大型設備で鑄造した鋳塊（素材）を加工した導体は $100\mu\text{m}$ 径あたりから異物断線が多発するが、小型の横型連続鑄造設備を用い通常のメンテナンスを行って鑄造した鋳塊（素材）は、 $30\mu\text{m}$ 径まで無断線で加工できる。しかし径が $20\mu\text{m}$ 前後の極細導体を無断線で伸線するには、異物は $12\mu\text{m}$ 径以下、望ましくは $10\mu\text{m}$ 径以下にする必要があり、そのためには、通常のメンテナンスだけでなく、例えば、溶湯を長時間鎮静して重い異物は炉底に沈降させ、軽い異物は湯面に浮上させ、中間部分の異物の少ない溶湯を鑄造するなどの特種な溶湯処理が必要になる。このようにすれば $17\mu\text{m}$ 径程度まで伸線加工が可能になる。請求項2、3記載の発明は、熱間加工或いは高温焼鈍を行わないので、酸化スケールが異物として混入する機会が少ない。

【0012】請求項2記載の発明は、鑄造組織のデンドライトアームスペース（DAS）が $15\mu\text{m}$ 以下、Ag晶出物が $15\mu\text{m}$ 以下の径で均一に分散した鋳塊を用い、加工率99.997%以上で冷間加工する巻線用極細導体の製造方法である。前記鋳塊を、DASが $15\mu\text{m}$ 以下、Ag晶出物が $15\mu\text{m}$ 以下の径で均一に分散する鑄造組織に規定する理由は、鋳塊の冷間加工性が向上し、また導体表面の凹凸欠陥が減少して絶縁被覆性が向上するためである。冷間加工の加工率を99.997%以上に規定する理由は、鋳塊中に分散するAg晶出物が短繊維状に微細に分散されるなど鑄造組織が十分に破壊されて極細導体のしなやかさが増しコイルリング性が向上するためである。

【0013】DASは溶湯凝固時の冷却速度に依存し、冷却速度の大きい小型鋳塊ほど小さくなる。即ち、図3に示すようにDASは縦型連続鑄造鋳塊（ $200\text{mm}\phi$ ）、SCR鋳塊（ $100\times 50\text{mm}$ ）、小型横型連続鑄造機鋳塊A（ $10\text{mm}\phi$ ）の順に小さくなる。鋳塊の大きさが同じ場合は、DASは鋳型の温度勾配に依存する。即ち、小型横型連続鑄造機の鋳塊の場合、鋳型の温度勾配を $50^\circ\text{C}/\text{cm}$ に設定した鋳塊AのDASは18

$\mu\text{m}$ 以上と大きく、鋳型の温度勾配を $100^\circ\text{C}/\text{cm}$ に設定した鋳塊BのDASは $15\mu\text{m}$ 以下に小さくなっている。つまり、DASが $15\mu\text{m}$ 以下、Ag品出物か $15\mu\text{m}$ 以下の径で均一に分散した鋳造組織の鋳塊は、小型の鋳型を用い鋳型の温度勾配を大きくして鋳造することにより得ることができる。

【0014】請求項3記載の発明は、請求項2記載の発明における冷間加工の途中に再結晶温度未満の温度で焼鈍を入れてトータルの加工率を向上させた巻線用極細導体の製造方法である。以下に前記焼鈍による効果を図4を参照して具体的に説明する。図4において、曲線aは、Agを3%含む $15\text{mm}$ 径の銅合金棒状鋳塊の加工硬化特性である。曲線aは、加工歪み $\epsilon$ が12で最大強度を示し、その後加工軟化するとともに延性が低下して伸線加工ができなくなる。 $\epsilon$ が13(線径 $22\mu\text{m}$ 、加工率99.99978%)で加工限界となる。

【0015】曲線bは、曲線aの材料を $\epsilon$ が8.71のイ点で比較的低温で焼鈍したときの加工硬化特性である。曲線bの最大強度は曲線aの最大強度と同程度で、そのときの $\epsilon$ ( $\epsilon_1$ )は15(線径 $5\mu\text{m}$ 、加工率99.99988%)に増加している。前記焼鈍は、内部を $700^\circ\text{C}$ の不活性ガス雰囲気とした長さ2mの走間焼鈍炉内を $200\text{m}/\text{分}$ の速度で通過させて行った。焼鈍後の引張強度は $985\text{N}/\text{mm}^2$ であり、この強度は曲線aの $\epsilon$ ( $\epsilon_1$ )が6に相当する強度であり、歪み除去率は $31\% = [(\epsilon_1 - \epsilon_2) / \epsilon_1 \times 100]$ である。前記強度 $985\text{N}/\text{mm}^2$ を、図5の静的焼鈍軟化特性に当てはめると、前記走間焼鈍は $300^\circ\text{C} \times 1$ 時間の静的焼鈍に相当し、再結晶温度未満である。なお、前記図5は、曲線aの材料の加工歪み $\epsilon$ が8.71のイ点(線径 $193\mu\text{m}$ 、加工率99.98%、引張強度 $1070\text{N}/\text{mm}^2$ )の静的焼鈍軟化特性である。このように、冷間加工の途中に再結晶温度未満の温度で焼鈍を入れることにより、高強度を維持してトータル加工率を高めることができる。従って、より極細の導体を得られ、または素材(鋳塊)径を大きくできて生産性が向上する。焼鈍を入れる導体サイズ

(径)は、焼鈍後の目標径までの伸線加工で導体強度が加工限界前の最高強度になるように選定するのが望ましい。前記焼鈍は再結晶温度未満の低温で行うのでエネルギー的に有利である。前記焼鈍は複数回繰り返し行っても良い。またインラインで行う方が、アウトラインで行うより生産性に優れる。バッチ焼鈍でも同様の効果を得られる。

【0016】曲線cは、曲線aの材料を $\epsilon$ ( $\epsilon_1$ )が8.71のイ点で比較的高温(再結晶温度以上の温度)で焼鈍したときの加工硬化特性である。曲線cの材料は $\epsilon$ が16.5(線径 $4\mu\text{m}$ 、加工率99.99993%)で断線しており、その破断強度は曲線a、bの材料よりかなり低い。この曲線cの材料は強度が低いので自動巻線機で断線し易くコイルリング性が悪い。この曲線cの材料は、

種々の伸線機を用いて何回か伸線加工したが、いずれも $4\mu\text{m}$ 前後で断線した。つまり $4\mu\text{m}$ が伸線加工限界である。伸線加工限界の導体は素材が何であれ使用を避けるべきである。曲線cの材料の焼鈍は、内部を $1000^\circ\text{C}$ の不活性ガス雰囲気とした長さ2mの走間焼鈍炉内を $150\text{m}/\text{分}$ の速度で通過させて行った。焼鈍後の引張強度は $420\text{N}/\text{mm}^2$ であり、この強度は曲線aの $\epsilon$ ( $\epsilon_1$ )が0.1に相当する強度で、歪み除去率は $99\% = [(\epsilon_1 - \epsilon_2) / \epsilon_1 \times 100]$ である。前記引張強度 $420\text{N}/\text{mm}^2$ を図5に当てはめると、前記走間焼鈍は $500^\circ\text{C} \times 1$ 時間の静的焼鈍に相当する。ミクロ組織観察で再結晶が終了していることが確認された。

【0017】

【実施例】以下に本発明を実施例により詳細に説明する。

(実施例1)電気銅に本発明規定内でAgを種々の量配合し、これを黒鉛るつぼで溶製し、金型にて $10\text{mm}$ 径の鋳塊に鋳造し、この鋳塊を $20\mu\text{m}$ 径の極細導体に伸線加工(加工率99.9996%)した。得られた各種細導体について、引張強度(TS)、導電率(EC)、伸線性、巻線性、および伸線性と巻線性の関係を調べた。比較のため本発明規定外組成のCu-Ag合金および無酸素銅についても同様に極細導体を製造し同じ調査を行った。結果を図6(イ)～(ホ)に示す。図6(イ)に引張強度とAg含有量との関係を示した。Agを1～4.5%含有する本発明例品は $940 \sim 1150\text{N}/\text{mm}^2$ の高強度であることが判る。Agが1%未満で引張強度は急激に低下する。図6(ロ)に導電率とAg含有量との関係を示した。Agを1～4.5%含む本発明例品は8.8.5～81.5%IACSの高い導電率を有することが判る。Agが4.5%を超えると導電率は規格値(81.5%)未満に低下する。図6(ハ)に $25\mu\text{m}$ から $20\mu\text{m}$ に伸線するときの伸線性(1断線あたりの伸線量)とAg含有量との関係を示した。Agを1～4.5%含む本発明例品は $1800 \sim 2500\text{g}/\text{Br}$ の高い伸線性を有することが判る。Agが1%未満では $20\mu\text{m}$ 径の極細導体の24時間連続伸線に必要な $1800\text{g}/\text{Br}$ の伸線性が保証されない。Agが1～3%での伸線性の向上は合金化による効果であり、4.5%を超えての伸線性の急激な低下は共晶組織の出現によるものである。図6(ニ)に巻線性とAg含有量との関係を示した。巻線性はエナメル被覆した $20\mu\text{m}$ 径の極細導体を手動巻線機または自動巻線機でコイルリングして磁気ヘッドを100個作製したときの断線回数で表した。Agを1～4.5%含む本発明例品の断線回数は、自動巻線機で4回以下、手動巻線機で1回以下でいずれも少ない。巻線性から見た特に望ましいAg含有量は1.5～4%である。図6(ホ)に伸線性(1断線あたりの伸線量)と巻線性(100コイル作製中の断線回数)との関係を示した。伸線性に優れる導体は巻線性にも優れている。図6

(イ)～(ホ)から、Cu-1～4.5%Ag合金からなる本発明の極細導体は、80%IACS以上の高導電性で、950～1150N/mm<sup>2</sup>の高強度を有し、しかも伸線性と巻線性に優れることが判る。

【0018】(実施例2)下記4種の素材(Cu-2%Ag合金)を伸線加工して25μm径の極細導体とし、これを20μm径まで400m/分(67g/hr)の速度で連続伸線して、断線に到るまでのトータル伸線時間を調べた。また破面に残存した異物または酸溶解法にて採取した異物の径をSEM観察により測定した。両者の関係を図7に示す。トータル伸線時間は、各3ボビンずつ連続伸線し、1回目の断線が起きるまでの連続伸線時間をボビンごとに測定し、その合計をトータル伸線時間とした。例えば、第1ボビンが5時間後に断線し、第2ボビンが3時間後に断線し、第3ボビンが4時間後に断線した場合のトータル伸線時間は12時間とした。1ボビン(最大巻量2500g)の伸線時間は37時間なので最大のトータル伸線時間は111時間である。また前記酸溶解法は極細導体を1ボビンあたり5か所から各100gずつサンプリングし、これを酸に溶かし濾過して採取する方法である。素材は次の4種である。①SCR方式で製造した8mmφの荒引線、②縦型連铸・押出方式で製造した10mmφの押出材、③通常メンテナンスの小型横型連铸装置を用いて製造した10mmφの鋳塊、④特殊な溶湯処理で異物を十分除去した溶湯を小型横型連铸装置を用いて製造した10mmφの鋳塊(本発明例)。図7より、トータル伸線時間は、異物が小さいほど長くなり、異物径が10μm以下の④材が最も長く、異物径が10μmを超える①～③材は伸線性が大幅に短くなっている。前記実施例ではCu-2%Ag合金について説

明したか、本発明はCu-1～4.5%Ag合金に適用して同様の効果が得られる。

【0019】前記④のボビン(20μm径、最大巻量2500g)に巻取った極細導体(Cu-2%Ag合金)を自動巻線機によりコイル化したか、折線は全く起きなかった。

【0020】前記④のボビン(20μm径、最大巻量2500g)に巻取った極細導体をさらに17μm径に連続伸線し、巻取ったボビンから前述と同じように酸溶解法により異物を採取し、異物径をSEM観察により測定した。異物径はいずれも10μm以下であった。

【0021】(実施例3)Agを2%または4%含む銅合金を溶製し、異物を沈降または浮上させ、中間部分の溶湯を小型横型連铸装置により10mm径の鋳塊に連続製造し、これを50～15μmの極細導体に伸線加工した。前記連铸装置での鋳型の温度勾配は100℃/cmにした。前記鋳塊の鋳造組織は微細で、DASおよびAg晶出物は15μm以下であり、Ag晶出物は均一に分散していた。比較のため、鋳型の温度勾配を50℃/cm以下にして連铸製造した鋳塊についても同様に50～15μmの極細導体に伸線加工した。この鋳塊は鋳造組織が比較的粗く、DAS、Ag晶出物とも18μm以上で、Ag晶出物は不均一に分散していた。得られた各々の極細導体について、伸線性(g/Br)、引張強度(TS)、導電率(EC)を調べた。結果を表1に示す。なお、伸線性は190→50μm、50→32μm、32→25μm、25→20μm、20→15μmにそれぞれ連続伸線したときの値である。

【0022】

【表1】

| 導体<br>径<br>μm | 鋳塊から<br>の冷間<br>加工率% | x Cu-2%Ag<br>15≧DAS, Ag晶出物 |            | y Cu-4%Ag<br>15≧DAS, Ag晶出物 |            | z Cu-2%Ag<br>18≧DAS,<br>Ag晶出物<br>伸線性 |
|---------------|---------------------|----------------------------|------------|----------------------------|------------|--------------------------------------|
|               |                     | 伸線性                        | TS/EC      | 伸線性                        | TS/EC      |                                      |
| 50            | 99.99750            | >5000                      | 1045/85.10 | >5000                      | 1095/82.35 | 4706                                 |
| 32            | 99.99897            | >5000                      | 1075/85.06 | >5000                      | 1125/82.27 | 4451                                 |
| 25            | 99.99937            | 3510                       | 1090/85.00 | 3360                       | 1140/82.15 | 1890                                 |
| 20            | 99.99960            | 2450                       | 1095/84.96 | 2347                       | 1150/82.11 | 730                                  |
| 15            | 99.99977            | 2275                       | 1105/84.85 | 2153                       | 1155/81.95 | 410                                  |

(注) 伸線性g/Br、TS(引張強度)N/mm<sup>2</sup>、EC(導電率)%IACS。

【0023】表1より明らかなように、鋳造組織が微細な鋳塊から得られた極細導体x、yは、前記鋳造組織が比較的粗い鋳塊から得られた極細導体zより伸線加工性

が優れた。なお、zの伸線加工性が25μm以下で悪い主な原因は鋳造条件が不適当なことで、線材の外部品質が悪かったためである。以上Agを2%または4%含む

銅合金について説明したが、Cu-1~4.5%Ag合金においても同様の効果が得られる。

【0024】(実施例4) 実施例3で製造した20 $\mu$ m径のCu-2%Ag合金導体x、zにエナメルを被覆してその絶縁特性を高圧均一性試験により評価した。高圧均一性試験は、走行するエナメル線と電極輪間に高圧を印加し、スパークの発生によりエナメル線の絶縁不良を

検知する試験である。試験条件はエナメル線の走行速度5m/分、印加電圧500Vとした。試験本数は長さ30mのエナメル線を30本とした。絶縁特性は1本当たりの平均スパーク発生数で表した。結果を表2に示す。

【0025】

【表2】

| け厚さ  | 6 $\mu$ m | 5 $\mu$ m | 4 $\mu$ m | 3 $\mu$ m | 2 $\mu$ m | ※銅塊の鑄造組織 |
|------|-----------|-----------|-----------|-----------|-----------|----------|
| 表1のx | 0         | 0         | 0         | 0         | 0.1       | 微細       |
| 表1のz | 0         | 0.03      | 0.1       | 0.7       | 1.4       | 比較的粗い    |

(注) ※DASとAg晶出物は15 $\mu$ m以下、Ag晶出物は均一分散。

DASとAg晶出物は18 $\mu$ m以上、Ag晶出物は不均一分散。

【0026】極細導体xは3 $\mu$ mのエナメル皮膜厚さで十分な絶縁効果が得られた。これは用いた銅塊が微細な鑄造組織のため導体表面の凹凸欠陥が減少したためである。極細導体zは用いた銅塊が比較的粗い鑄造組織のため十分な絶縁効果を得るのに6 $\mu$ m以上のエナメル皮膜厚さが必要であった。

【0027】前記極細導体x、zのエナメル被覆線を自動巻線機にてフロッピーディスク用磁気ヘッドに各々100個づつコイルリングし、そのときの断線回数を調べた。結果を表3に示す。

【0028】

【表3】

| け厚さ  | 6 $\mu$ m | 5 $\mu$ m | 4 $\mu$ m | 3 $\mu$ m | 2 $\mu$ m | ※銅塊の鑄造組織 |
|------|-----------|-----------|-----------|-----------|-----------|----------|
| 表1のx | 0         | 0         | 0         | 0         | 0         | 微細       |
| 表1のz | 0         | 0         | 1         | 2         | 2         | 比較的粗い    |

(注) ※DASとAg晶出物は15 $\mu$ m以下、Ag晶出物は均一分散。

DASとAg晶出物は18 $\mu$ m以上、Ag晶出物は不均一分散。

【0029】表3より明らかなように、極細導体xは無断線であったが、極細導体zは一部に断線が発生した。これはDASとAg晶出物が大きくまたAg晶出物の分散が不均一で極細導体のしなやかさが不足したためである。

【0030】(実施例5) 図4に示したAgを3%含む15mm径の銅合金棒状銅塊の加工硬化曲線bと加工硬

化曲線c(比較例)の極細導体(37~8.3 $\mu$ m)の引張強度(TS)を調べた。また各々の極細導体に3 $\mu$ m厚さにエナメルを被覆し、このエナメル被覆線を自動巻線機でコイルリングしたときの断線回数を調べた。結果を表4に示す。

【0031】

【表4】

|                          |      |            |            |            |            |
|--------------------------|------|------------|------------|------------|------------|
| 導体径 $\mu m$              |      | 3 7        | 2 2        | 1 4        | 8. 3       |
| 全加工歪 $\epsilon$          |      | 1 2. 0     | 1 3. 0     | 1 4. 0     | 1 5. 0     |
| 全減面率 %                   |      | 99. 999391 | 99. 999784 | 99. 999912 | 99. 999969 |
| T S<br>N/mm <sup>2</sup> | 曲線 b | 1 0 8 0    | 1 1 1 5    | 1 1 4 0    | 1 1 5 0    |
|                          | 曲線 c | 8 7 5      | 9 3 0      | 9 8 4      | 1 0 1 0    |
| コイル<br>時の断<br>線回数        | 曲線 b | 0          | 0          | 0          | 0          |
|                          | 曲線 c | 1          | 2          | 2          | 3          |

【0032】表4より明らかなように、本発明例の極細導体（曲線b）は、比較例の極細導体（曲線c）より引張強度が、いずれの導体径においても高かった。比較例の極細導体は引張強度が低いため自動巻線機でのコイルリング時に断線が生じた。以上Agを3%含む銅合金について説明したが、それ以外のCu-1~4.5%Ag合金に適用しても同様の効果が得られる。

【0033】

【発明の効果】以上に述べたように、本発明の巻線用極細導体は、銀を適量含む高強度の銅合金からなり、しかもそこに含まれる異物の径を規定するので伸線性および巻線性に優れる。本発明の巻線用極細導体は、鋳造組織のDASとAgの晶出物径などを規定した鋳塊を99.997%以上の加工率で冷間加工することにより容易に製造できる。前記冷間加工の途中に再結晶温度未満の温度で焼鈍を入れることによりトータル加工率を大きくすることができ、導体の極細化または素材の大型化が図れ

る。

【図面の簡単な説明】

【図1】伸線性に関する異物径と導体径の関係を示す図である。

【図2】伸線性と異物占積率との関係を示す図である。

【図3】DASと鋳塊径の関係を示す図である。

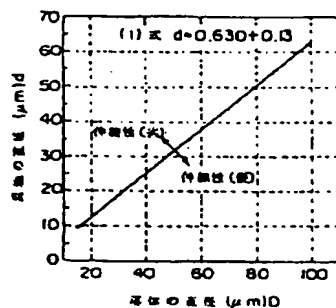
【図4】引張強度と加工歪みの関係（加工硬化特性）を示す図である。

【図5】引張強度と焼鈍温度の関係（焼鈍軟化特性）を示す図である。

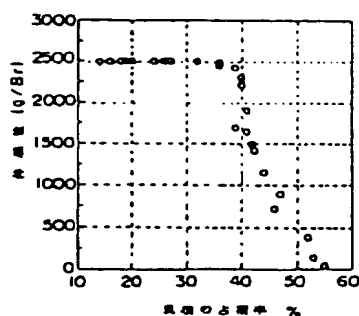
【図6】本発明の巻線用極細導体におけるAg含有量と引張強度（i）、導電率（ii）、伸線性（iii）、巻線性（iv）との関係、および伸線性と巻線性の関係（v）を示すそれぞれ説明図である。

【図7】20 $\mu m$ 径の極細導体における伸線性と異物径との関係を示す図である。

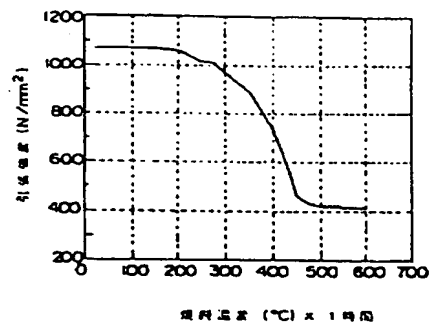
【図1】



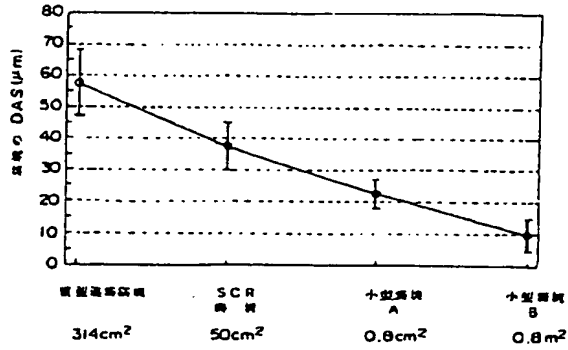
【図2】



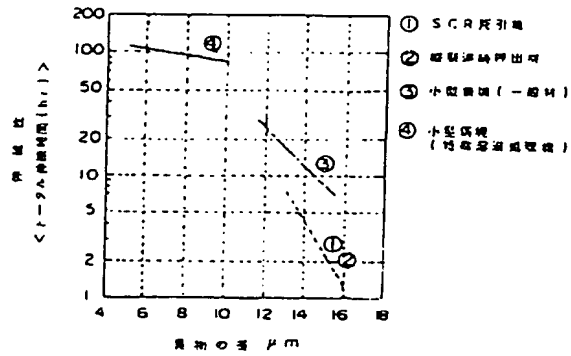
【図5】



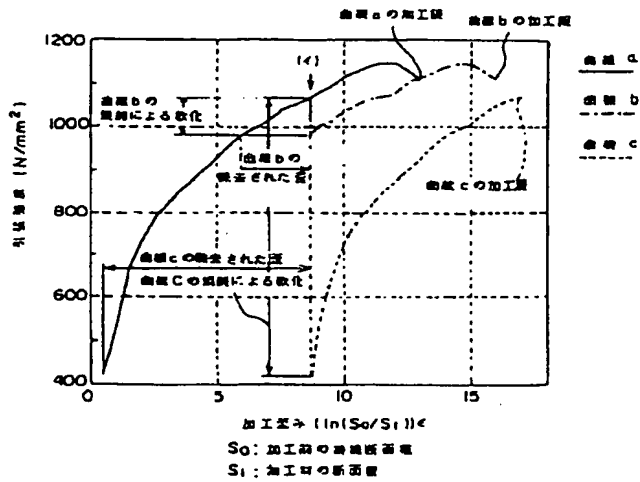
【図3】



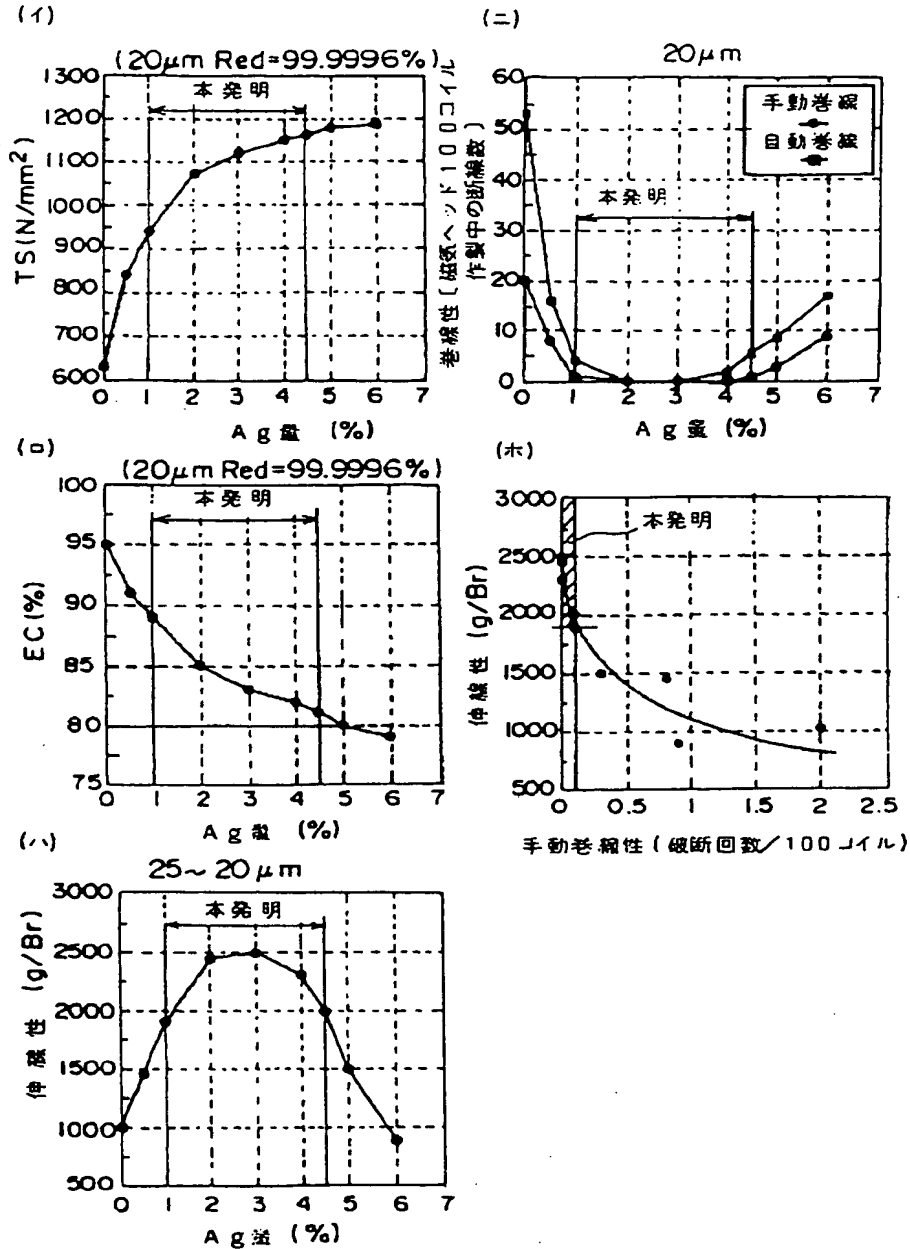
【図7】



【図4】



【図6】



フロントページの続き

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